The ILD DBD

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Excellence Cluster Universe

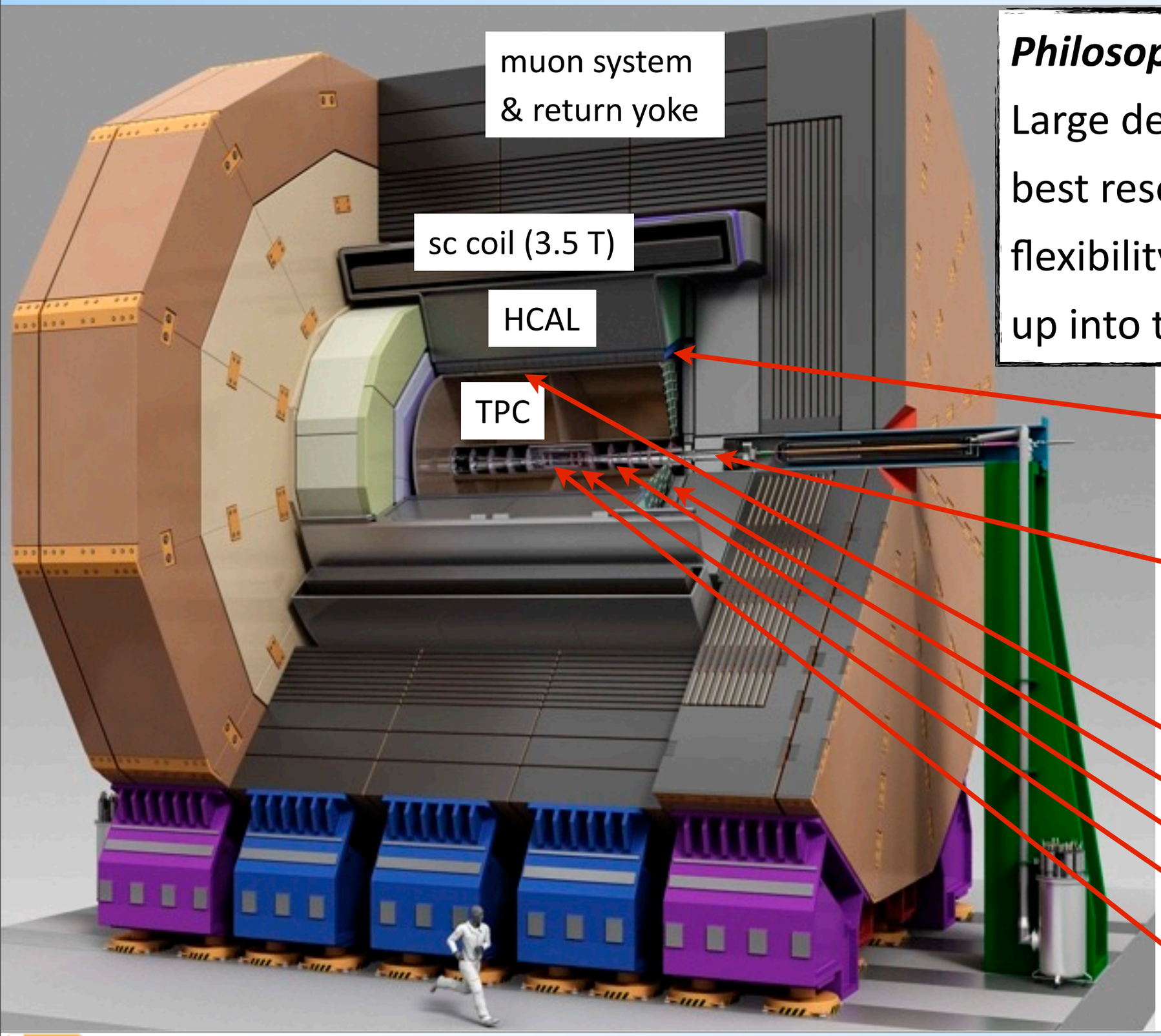
Outline

- The ILD Concept
  - Overview
  - Subsystems
- The ILD Detector System
- Software & Performance
- Summary

From the LOI to the DBD

The ILD Concept

ILD - Overall Design



Philosophy:

Large detector optimized for best resolution, providing flexibility for higher energies up into the TeV range

ECAL

forward calorimeters

LumiCAL

BeamCAL, LHCAL

silicon tracking

Silicon **E**xternal **T**racker

Endplate **T**racking **D**etector

Forward **T**racking **D**isks

Silicon **I**nner **T**racker

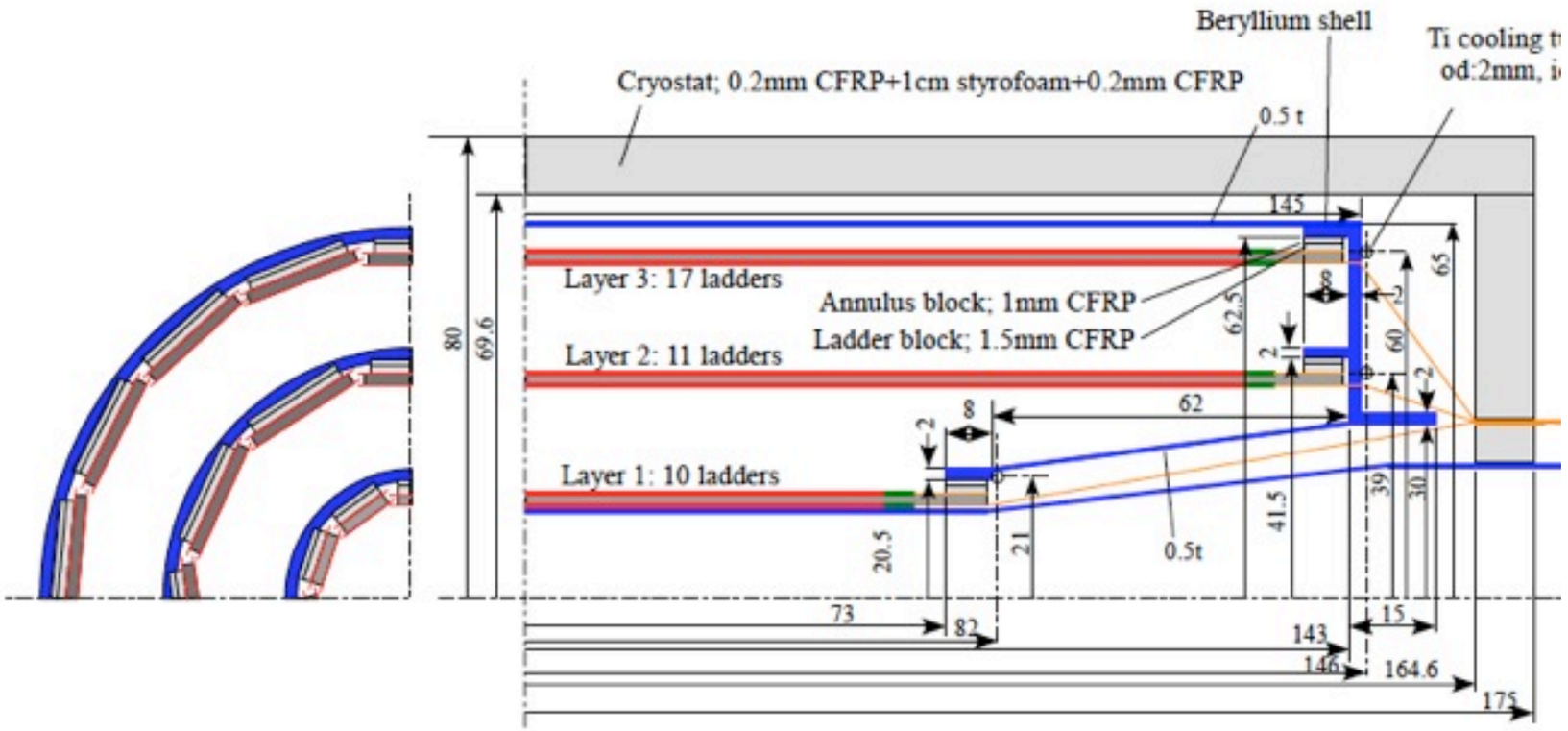
Ver**T**e**X** Detector

ILD Design - General Considerations & Challenges

- Performance goals set by physics
  - Jet energy resolution < 3% - 4% over full relevant energy range
  - Track momentum resolution $\delta(1/p_T) \simeq 2 \times 10^{-5}/\mathrm{GeV}/c$
  - Excellent vertexing for b & c identification

- Resulting main requirements and challenges
  - Highly granular PFA calorimeters
  - Low material budget in front of calorimeter
  - Power-pulsing, low power consumption
  - Triggerless readout
  - Highly integrated electronics

The Vertex Detector



- Performance goal:

$$\sigma_b < 5 \oplus 10/p\beta \sin^{3/2}\theta \ \mu\mathrm{m}$$

- Requirements:
  - Spatial resolution < 3 µm close to IP
  - Material budget < 0.15% X_0 per layer
    - low power consumption!
  - Pixel occupancy not exceeding a few %

- VTX design:
  - 3 (almost) cylindrical layers pairs from 16 mm to 60 mm
    - Alternative: 5 single layers, from 15 mm to 60 mm
  - Several technologies under study: CMOS Pixel Sensors, Fine Pixel CCDs, DEPFET, use of multiple technologies an option
  - Time stamping depends on technology

Vertex Detector Technologies

- Active development of several technologies, synergies with LHC & others

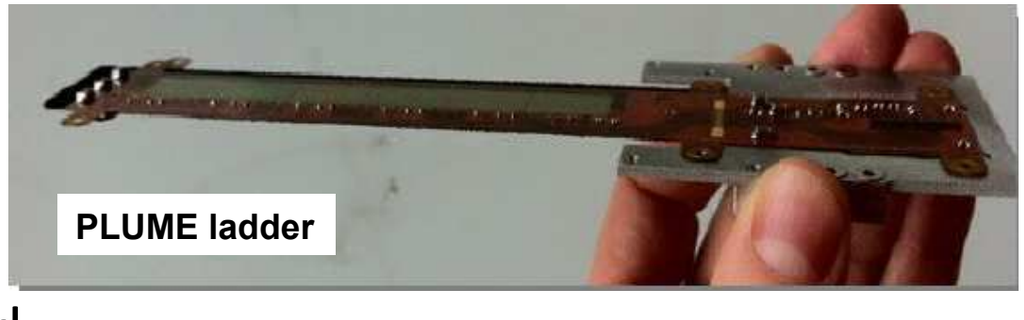
  - All provide low material budget by thin sensitive layers

    - Trade-off between readout speed and pixel size (no time stamping)

- CMOS pixel sensors

  - ~ 17µm pixel precision layers, 17 x 85 µm^2 pixel fast layers to reduce effective occupancy

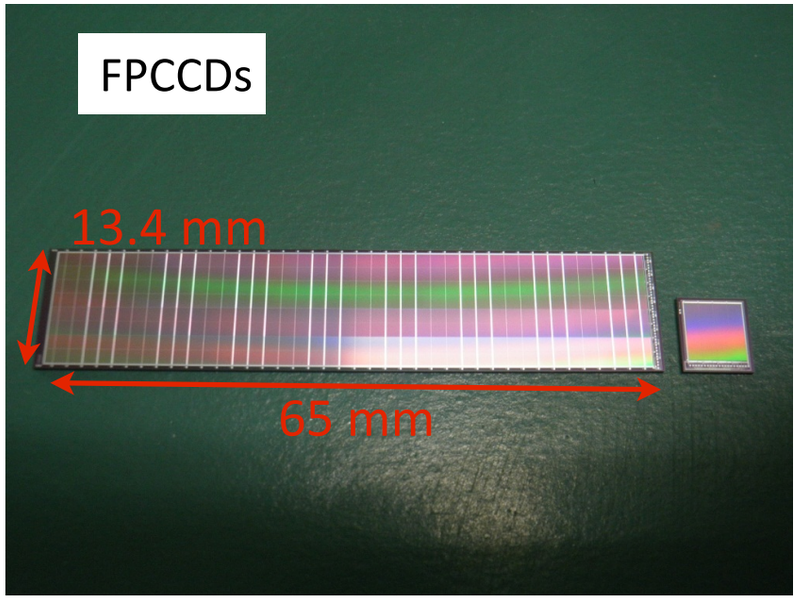
  - Low material double layer “PLUME” demonstrated



- FinePitch CCDs

  - ~ 5 µm pixels in inner layers, ~10 µm pixels further out

  - Small prototype successfully tested, (almost) full size prototype availabe



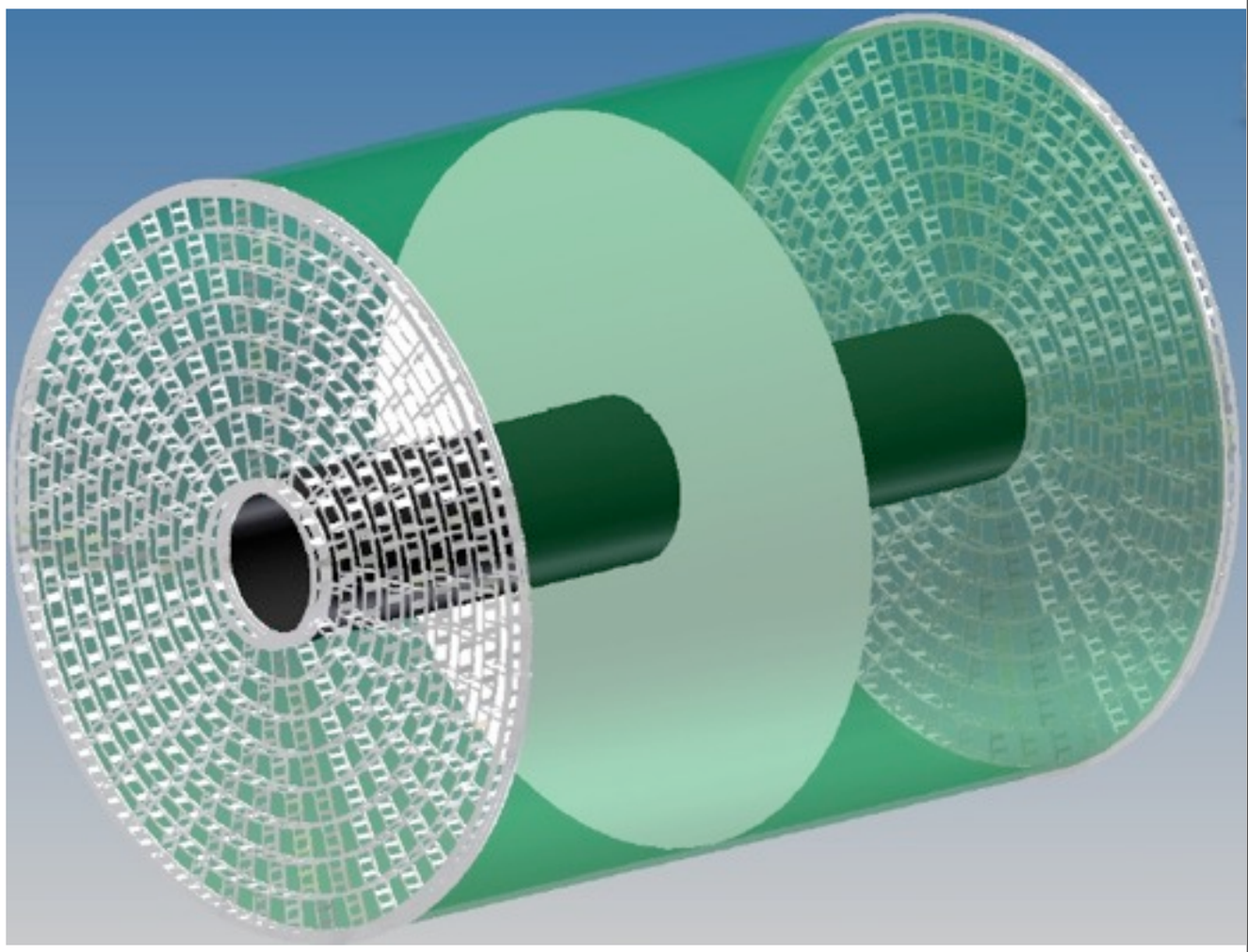
- DEPFETs

  - ~ 20 µm pixels, all-silicon modules with integrated support structure

The Main Tracker: TPC

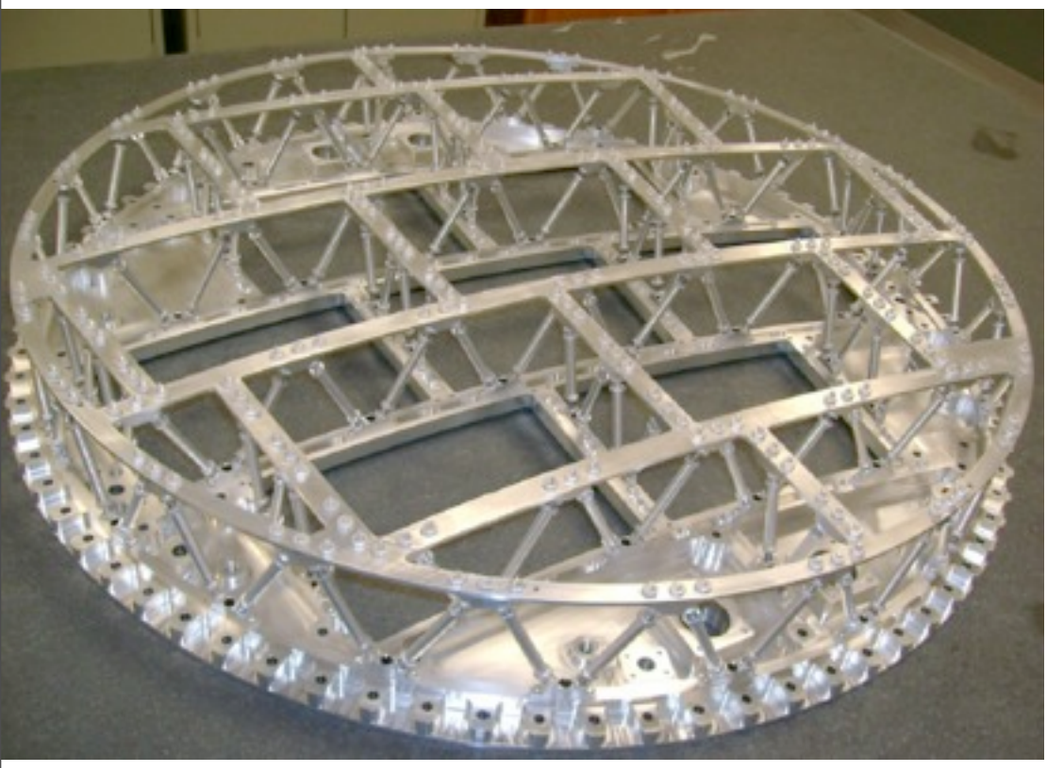
- Main tracker philosophy:
  Continuous tracking for excellent pattern recognition and dE/dx capability instead of best possible single point resolution
- The ILD TPC
  - Up to 224 space-points per track
  - Single point resolution < 100 µm in rϕ
  - Two-hit separation ~ 2 mm in rϕ
  - Low material budget: 5% X_0 in barrel region, <~ 25% X_0 in the endcaps
  - Standalone momentum resolution

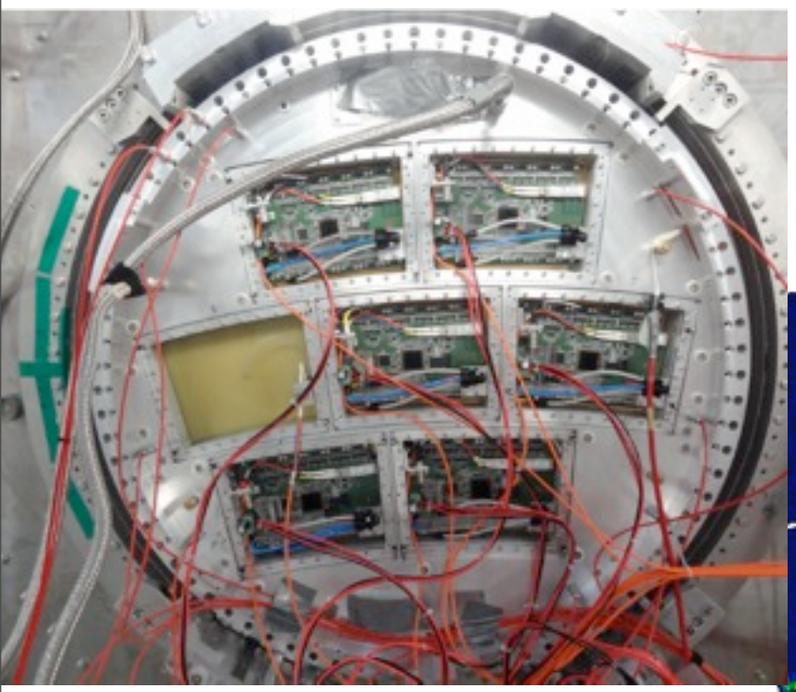
$$\delta(1/p_T) \simeq 10^{-4}/\mathrm{GeV}/c$$

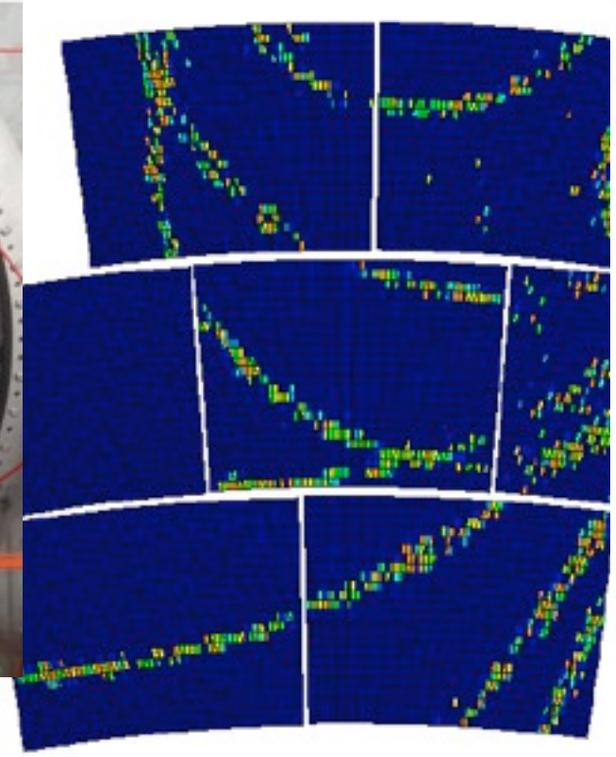


Two main readout options:
GEMs, Micromegas
Alternative: pixel detectors

TPC Development

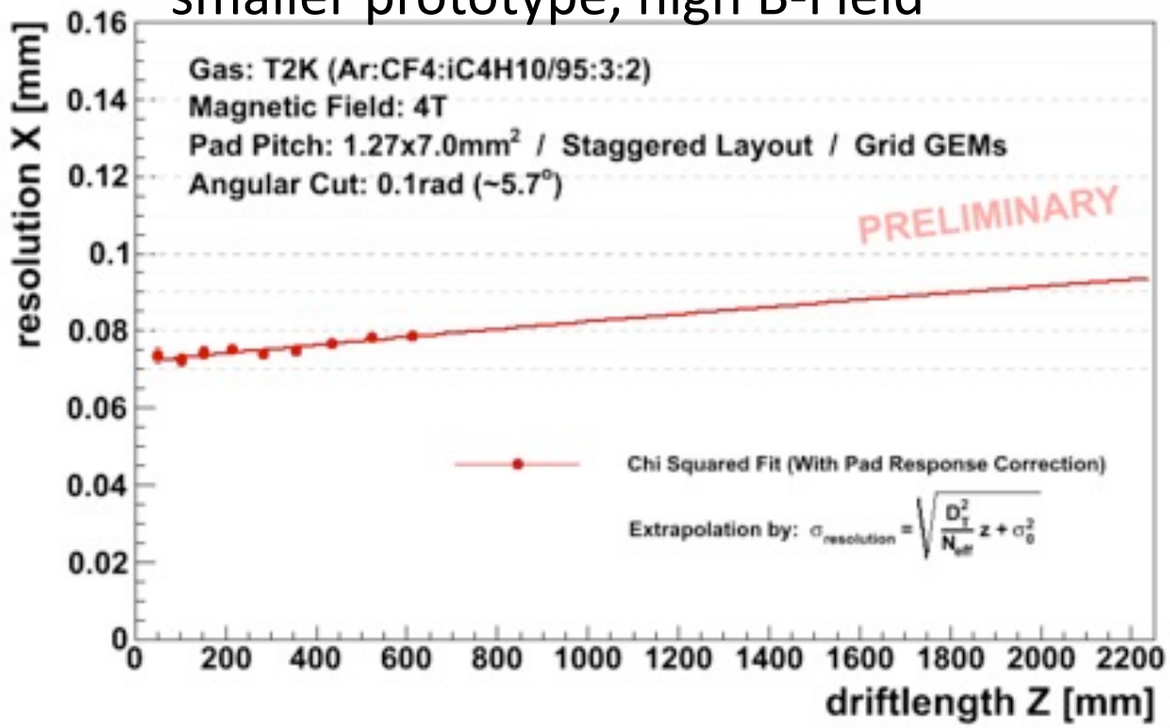






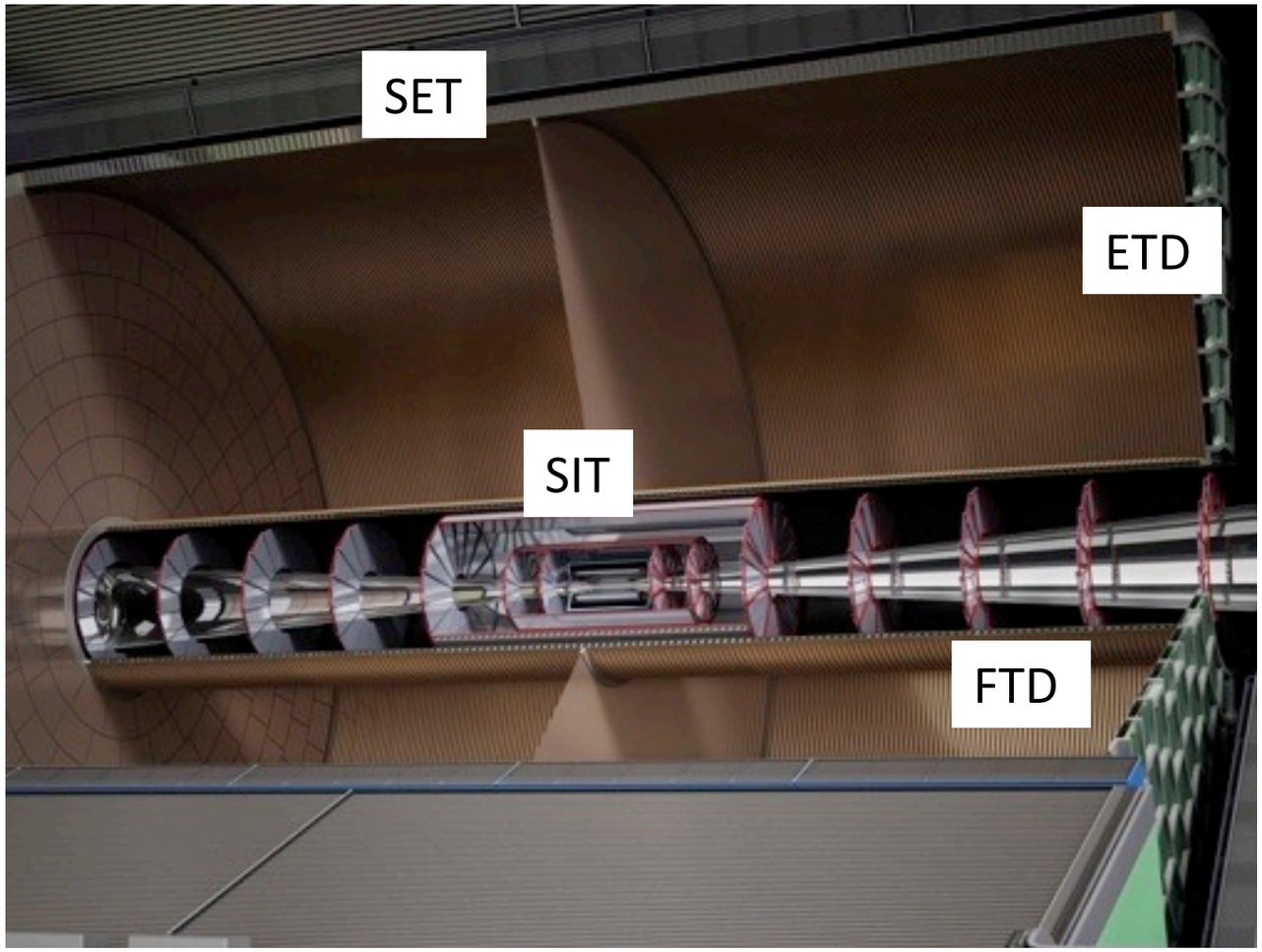
- Large prototype with “space frame” endplate
- Test in magnetic field up to 4 T
- Two readout technologies already tested:
  Triple-GEM, Micromegas

smaller prototype, high B-Field



extrapolated resolution < 100 µm
also beyond 2000 mm!

The Silicon Trackers



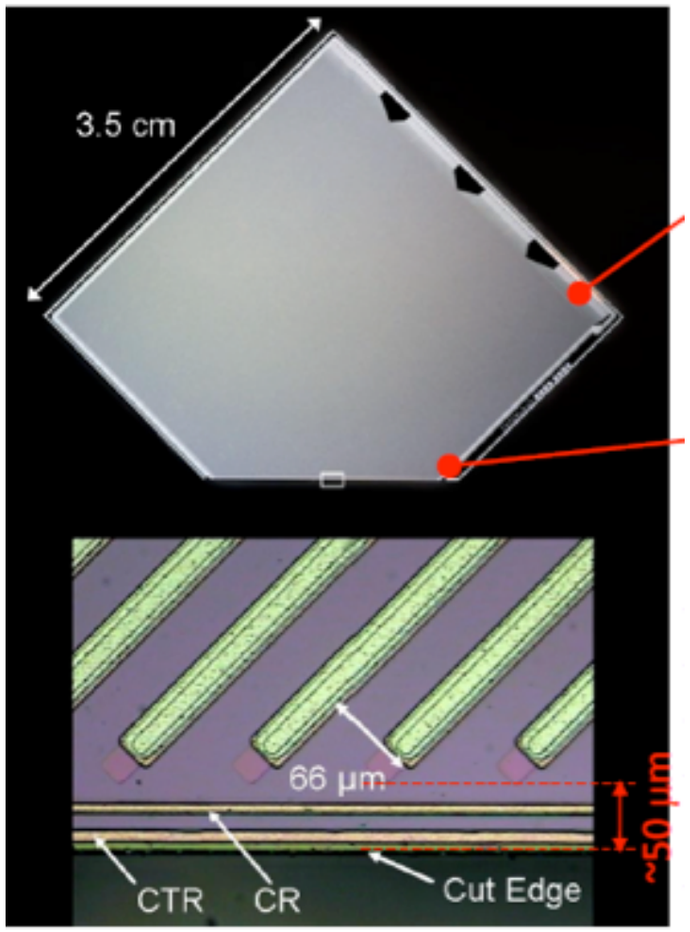
- Silicon tracking to complement the TPC main tracker:
  - Improved resolution
  - Time-stamping
  - Calibration of distortions & alignment
  - Extended coverage in the forward region
- Combined tracker resolution:

$$\delta(1/p_T) \simeq 2 \times 10^{-5}/\mathrm{GeV}/c$$

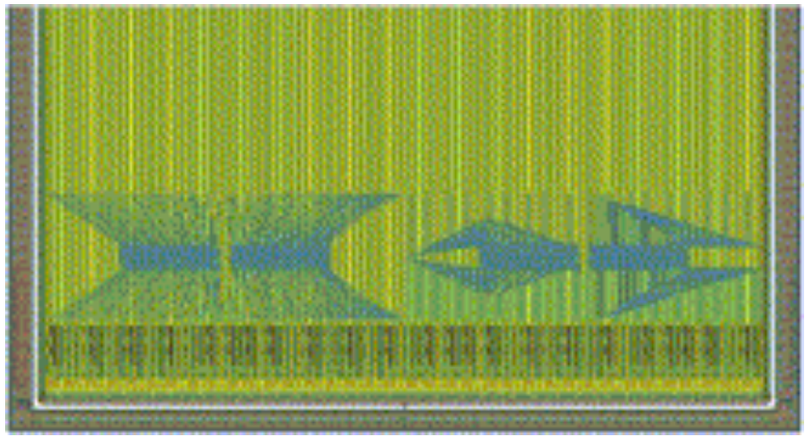
- Inner tracking barrel SIT - 2 fake double-sided strip layers, 2 space points
- Outer tracking barrel SET - 1 fake double sided strip layer, 1 space point
- Outer forward tracking layer ETD - 1 fake double sided strip layer, 1 space point
- Inner forward tracker FTD - 7 disks (2 pixel, 5 strip)
- Common technology & design for all strip sensors in the silicon trackers

Silicon Tracker Technology

- Philosophy: Compact, simple and cost-effective modules
- Edgeless sensors and integrated pitch adapters developed in synergy with LHC upgrades

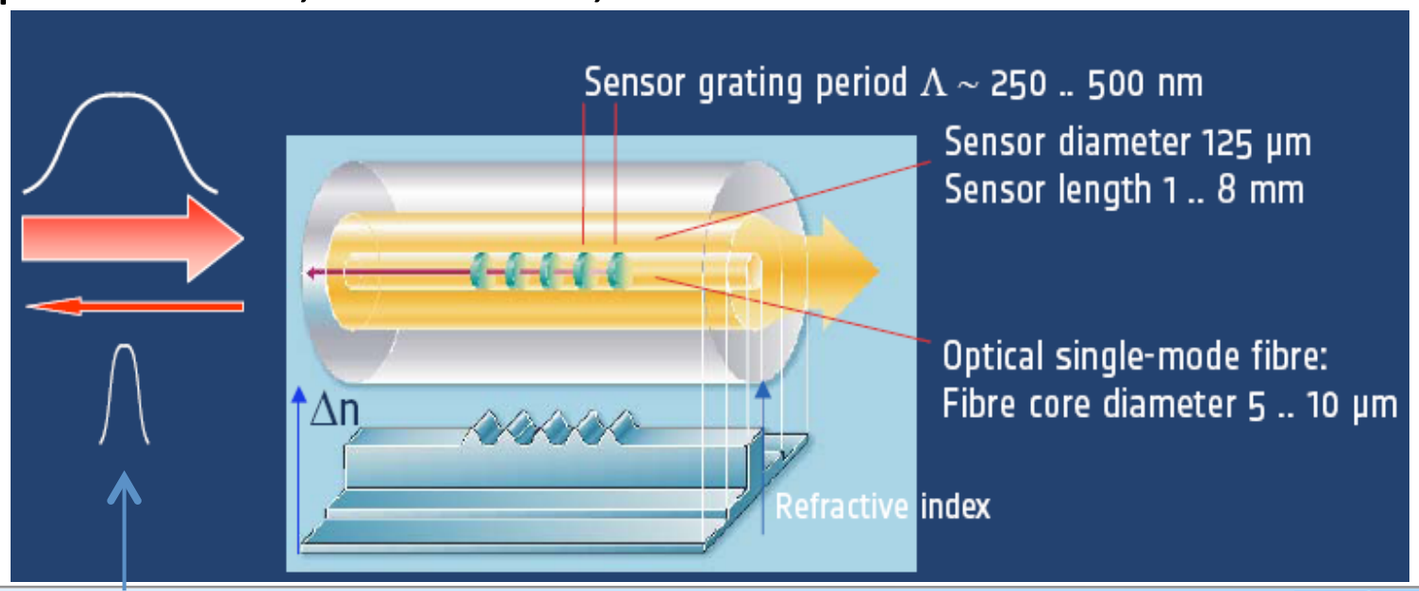


Only 50µm from end of strip to end of sensor!!!

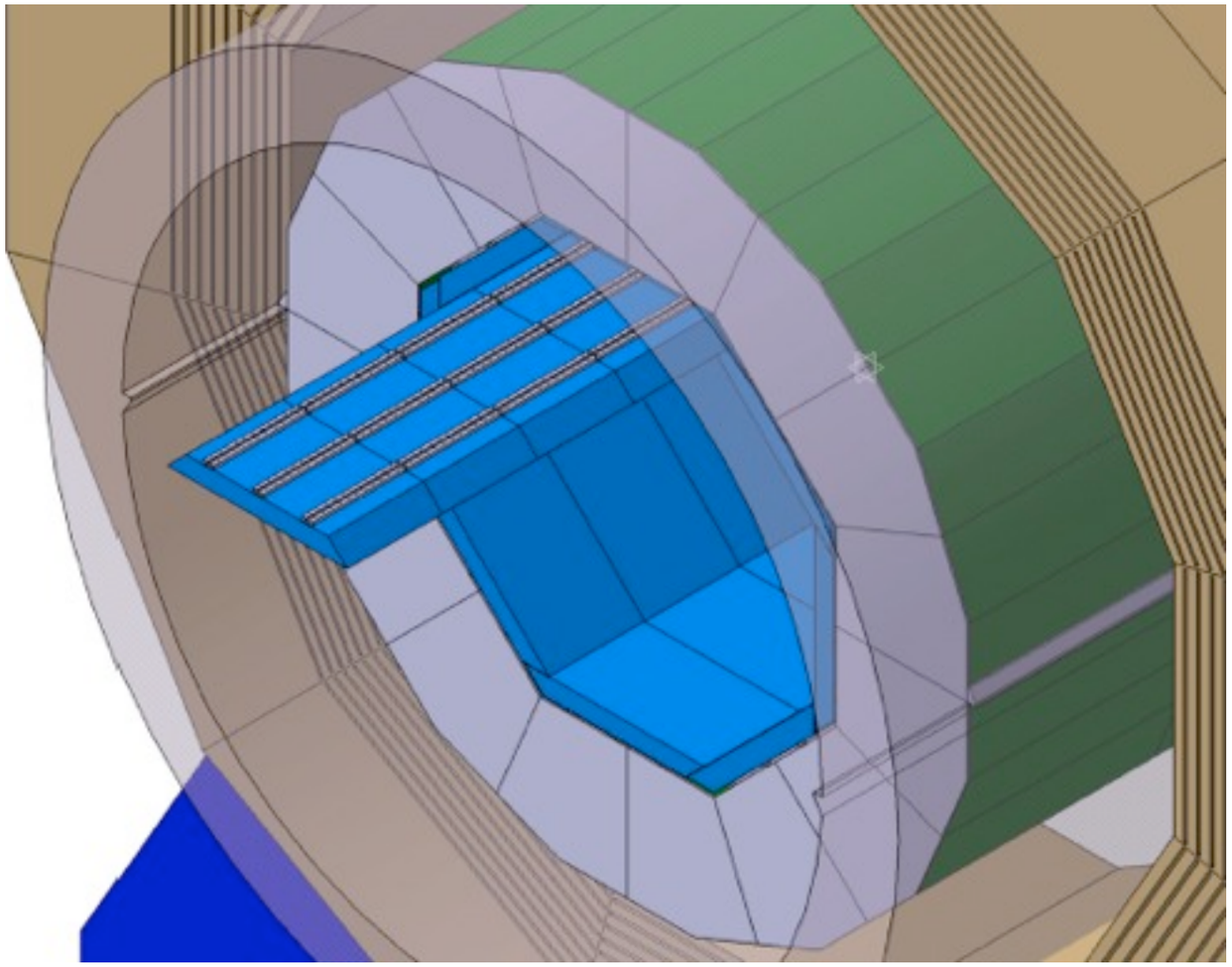


integrated pitch adapter in a second metal layer

Interferometric monitoring of FTD with fiber-optic sensors: Monitor changes of environmental parameters, vibrations, ...



The Main Calorimeters



- Main calorimeters optimized for particle flow:
  - High granularity
  - Small Molière radius in ECAL for good particle separation & photon identification
  - Sufficient depth of the HCAL to limit leakage also at 1 TeV
  - Compact design to fit inside magnet

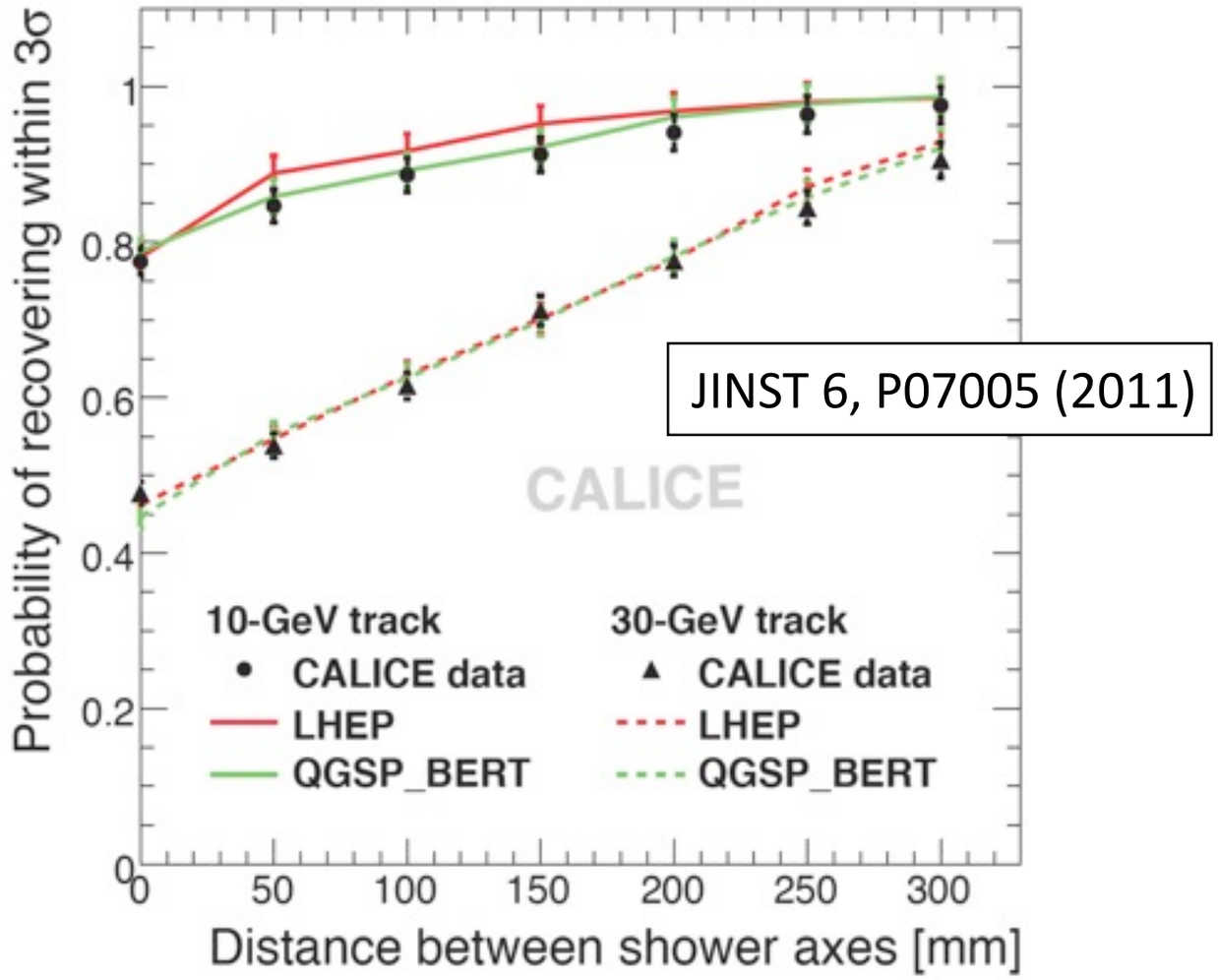
- ECAL with tungsten absorbers and silicon and/or scintillator readout
- HCAL with steel absorbers
  - Analog - Scintillator tiles with SiPMs
  - Semi-digital - Glass RPCs with 2 bit readout, Micromegas as alternative

Calorimeter R&D

- Calorimeter technology for ECAL & HCAL developed by CALICE:
  Combined test-beam experiments
  to demonstrate PFA calorimetry

One highlight:
Shower separation with PandoraPFA
in the SiW-ECAL and AHCAL physics
prototypes

- Good agreement with simulations demonstrates realism of our full detector simulations & physics studies

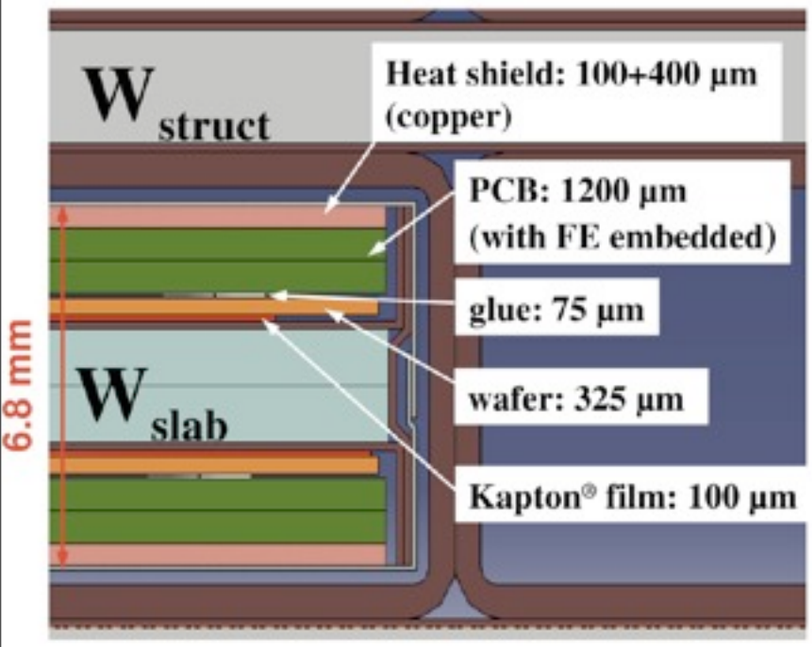


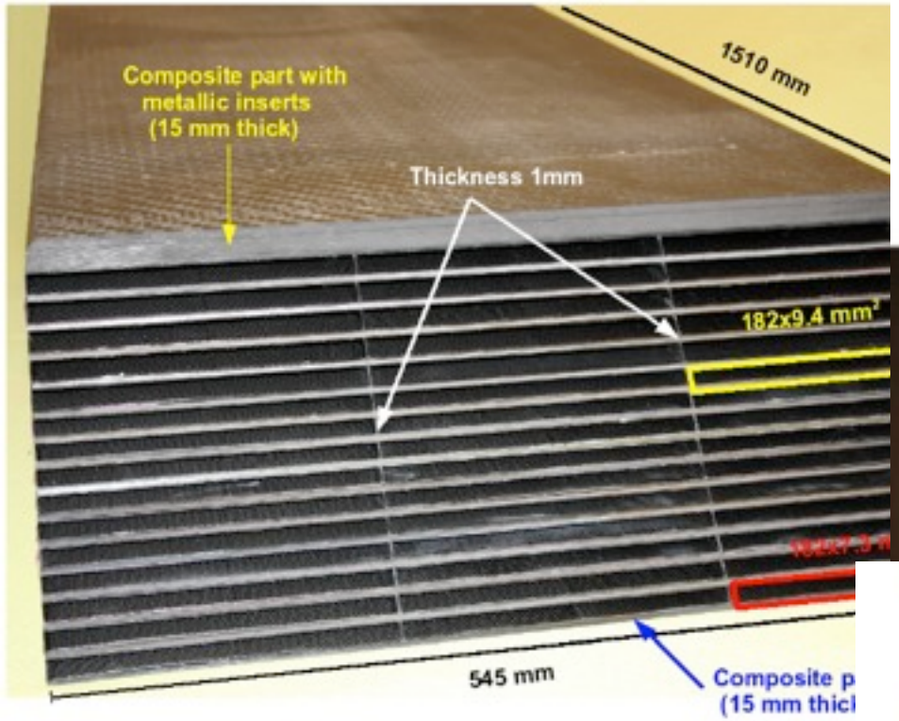
JINST 6, P07005 (2011)

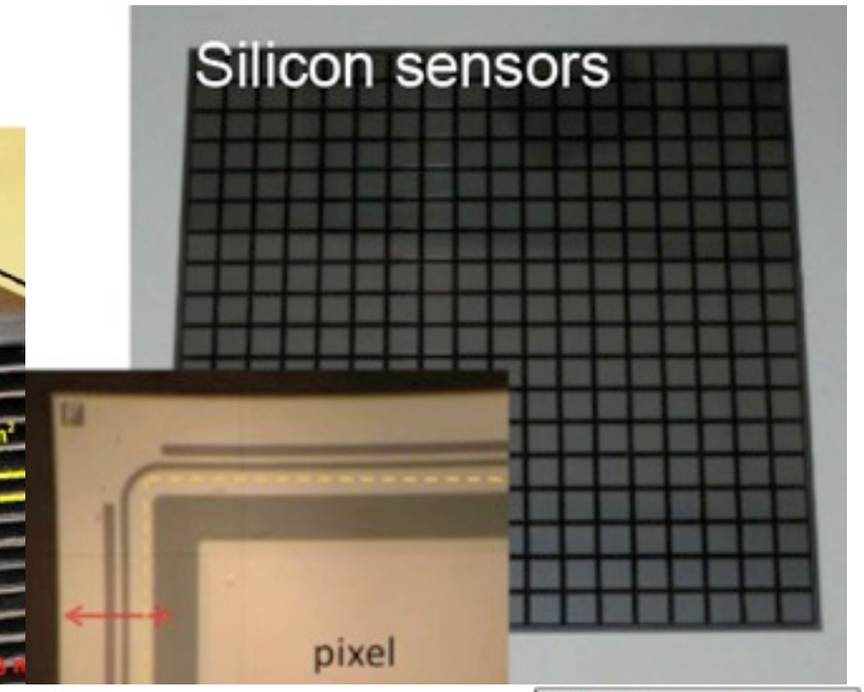
- Readout ASICS for all calorimeter types with a common basis
- Common DAQ system, data format:

The SiW ECAL

- PIN silicon pad readout with 5.5 x 5.5 mm^2 pads



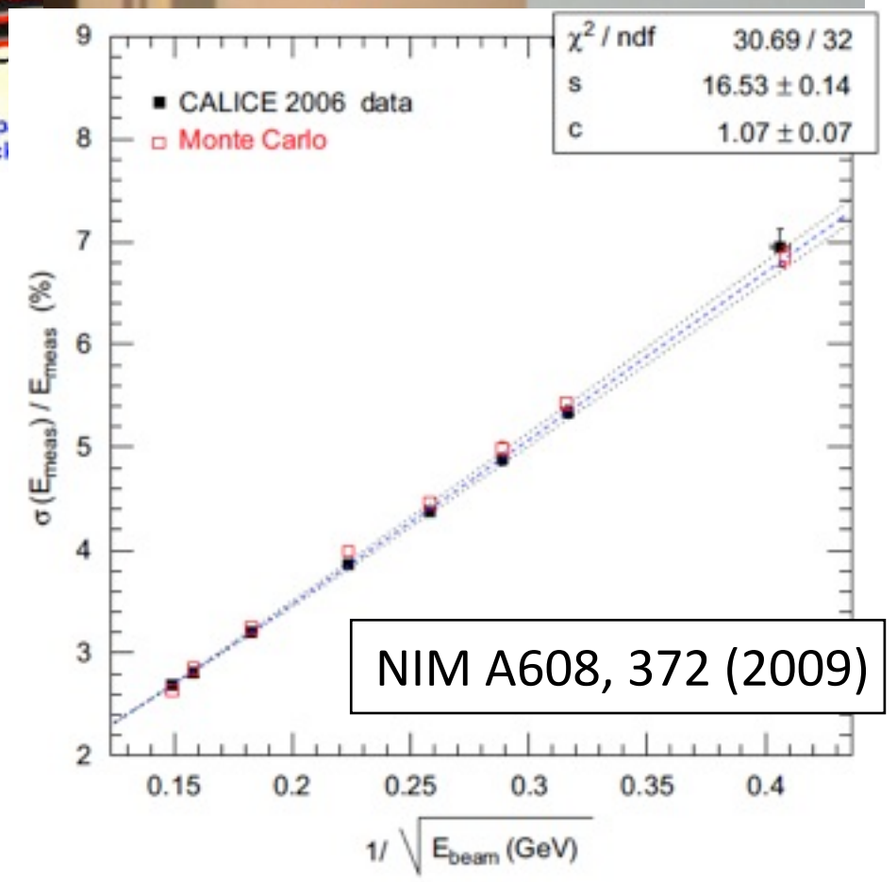




6.8 mm per double layer

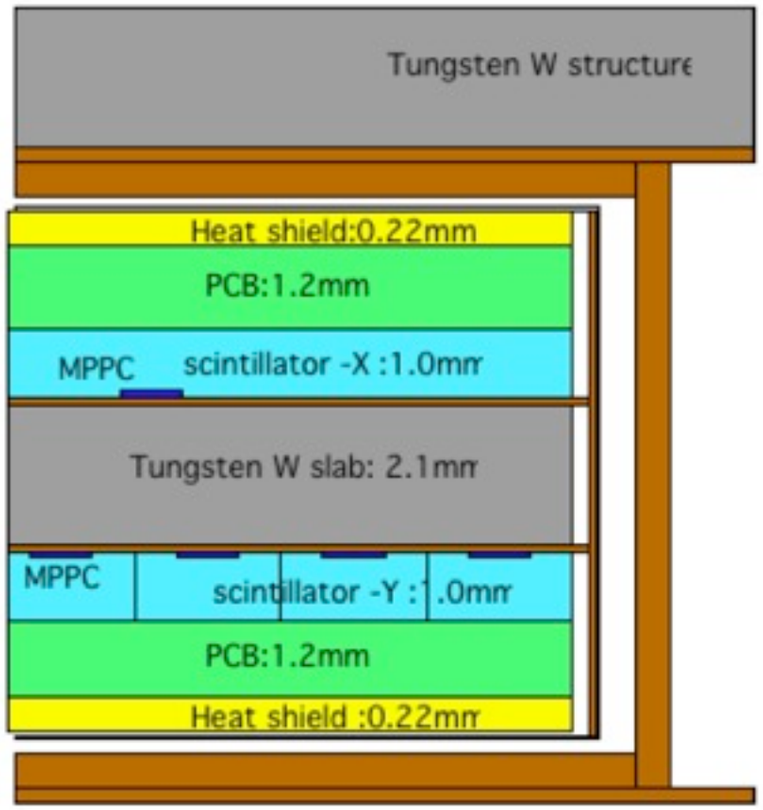
Complete tungsten structure for technological prototype exists

Well-established technology: physics prototype in various beam times since 2006

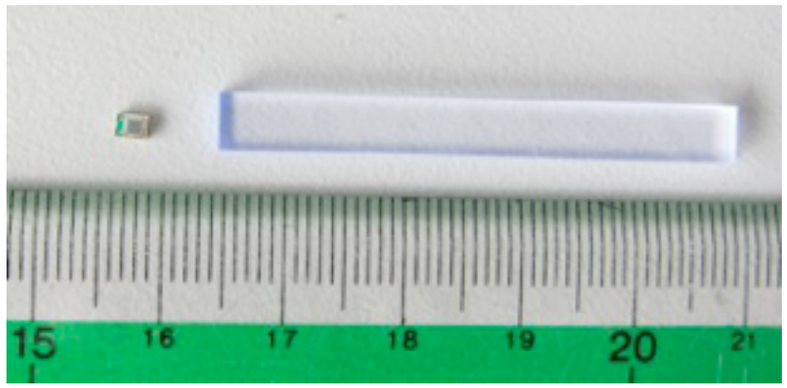


NIM A608, 372 (2009)

The Scintillator ECAL



- Scintillator strips (5 x 45 x 1 mm^3) read out with SiPMs
  - 6.9 mm per double layer, 0.1 mm more than SiW ECAL
  - Electronics based on AHCAL design - synergies!



Extensive tests with a physics prototype, first module of technological demonstrator now in test beam at DESY

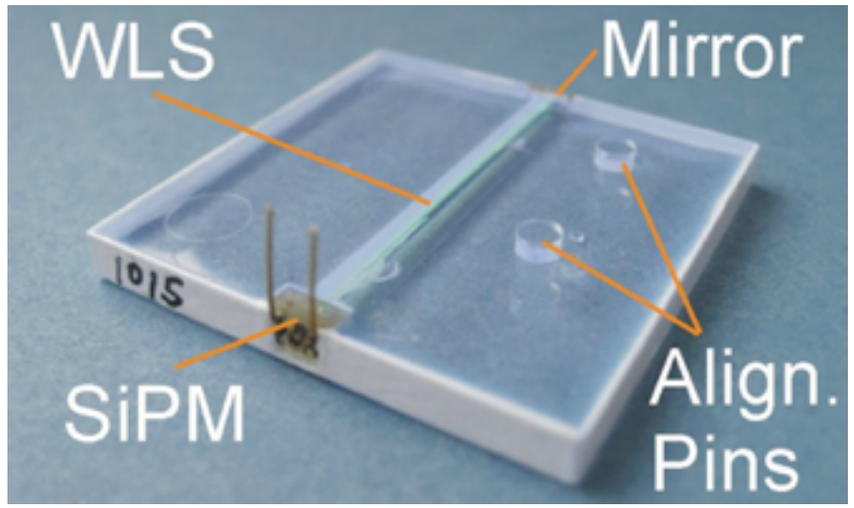
- Recover 5 x 5 mm^2 granularity with strip-splitting algorithm
- SiPMs / MPPC with higher smaller pixels under study to increase dynamic range
- Hybrid solutions together with Si layers (interleaved or as two sections) possible

Updated resolution plot?

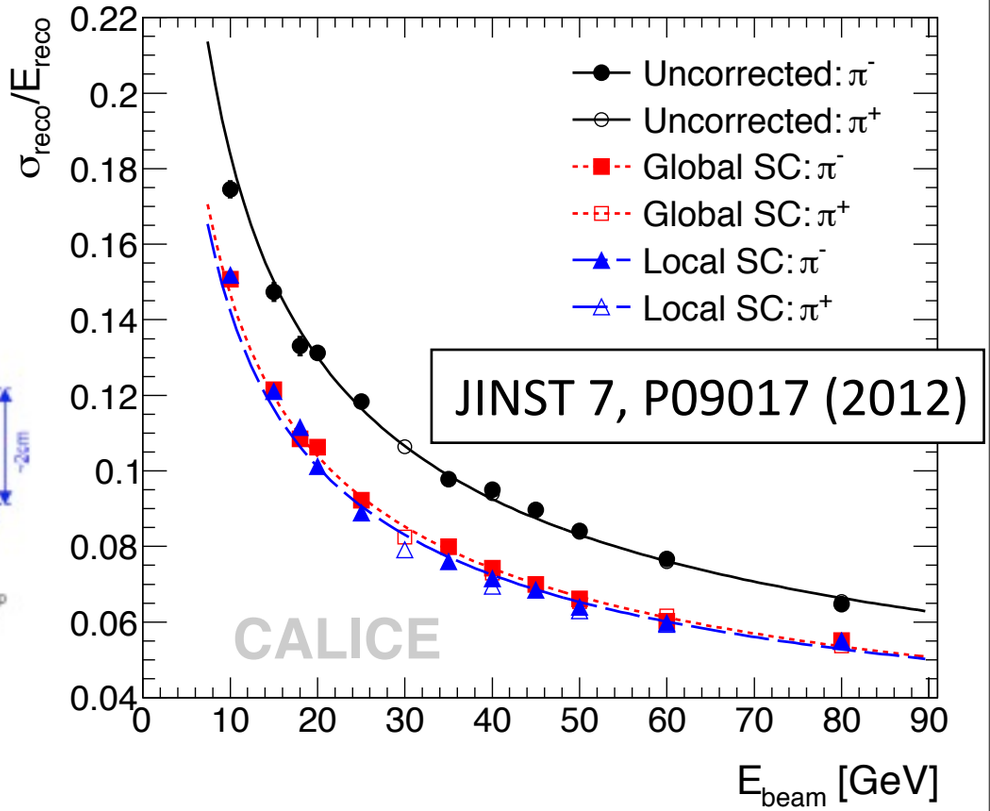
-> Currently under review in CALICE

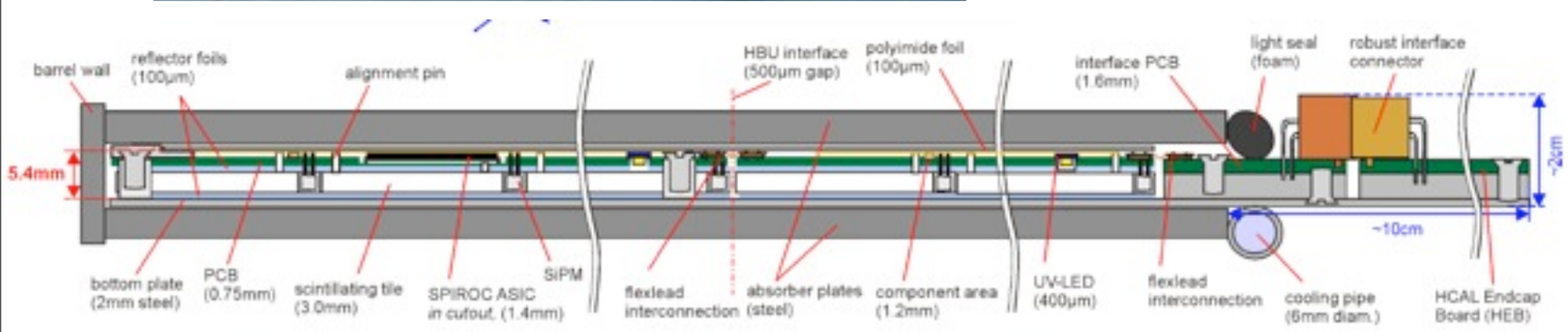
The Analog HCAL

- Based on 3 x 3 x 0.3 cm^3 scintillator tiles with embedded SiPM



Well-established technology: Extensive tests in beam with a 8 000 channel system since 2006



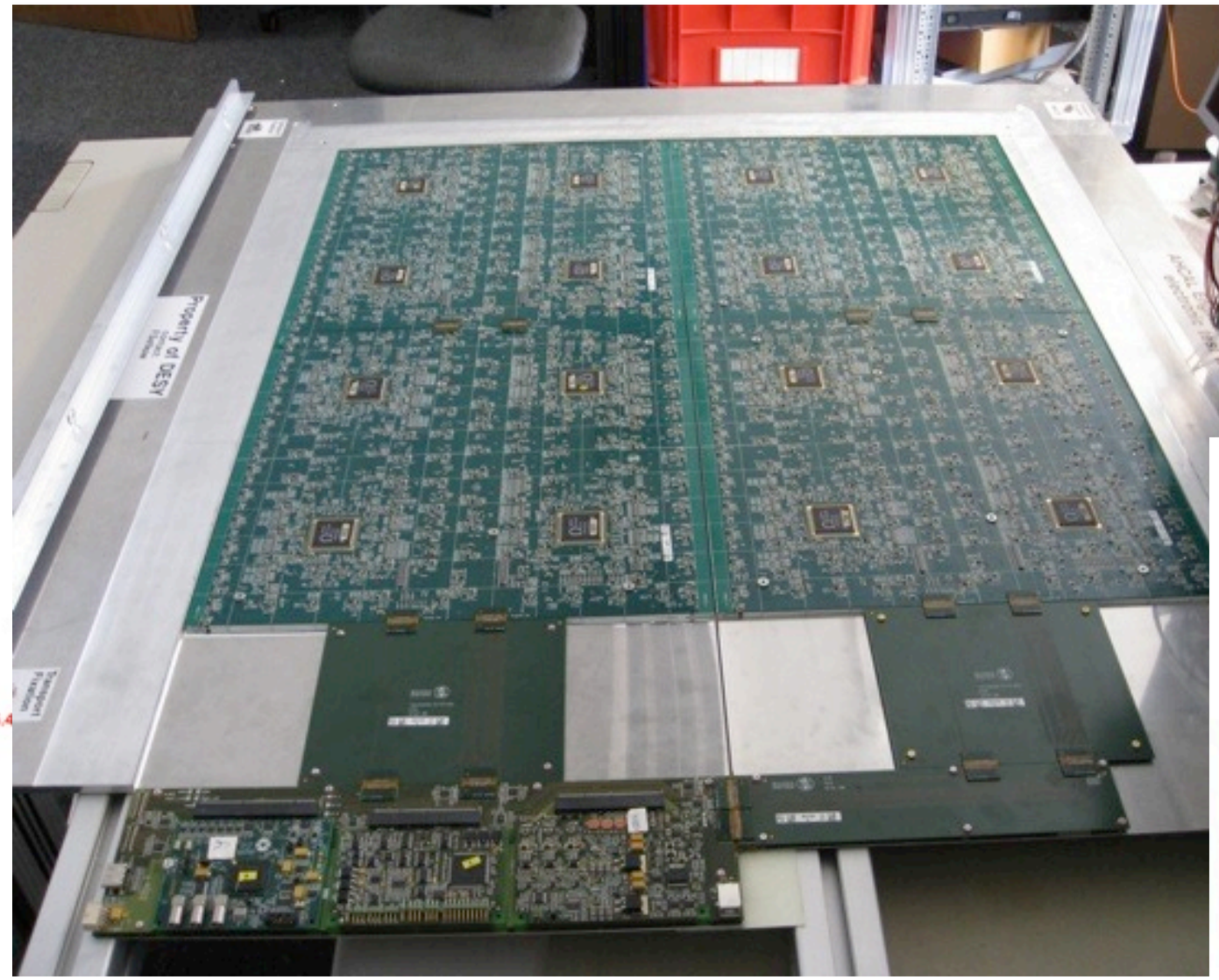


Compact design: < 6 mm non-absorber material per layer

Hadronic energy resolution of physics prototype with software compensation:

45%/√E ⊕ 1.8%

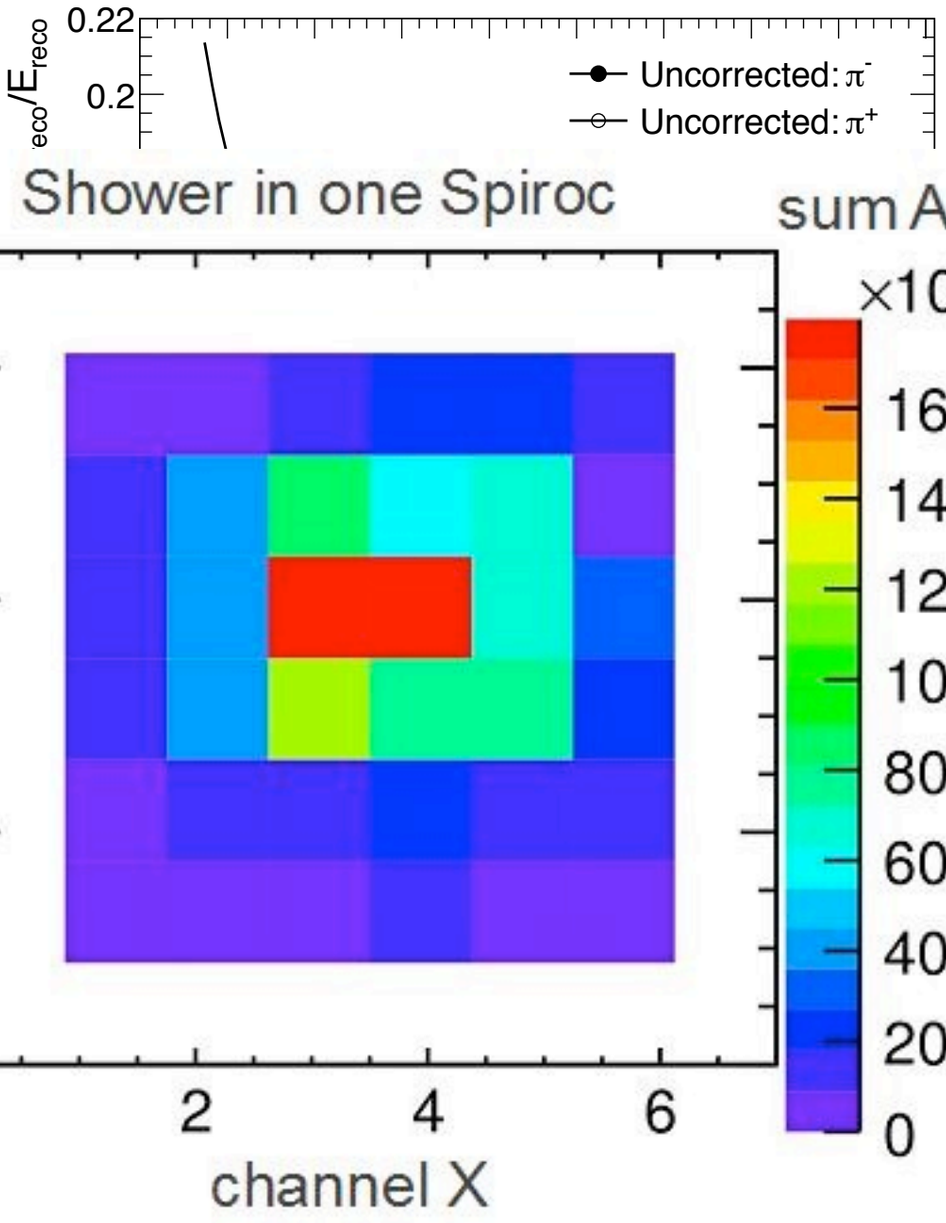
The Analog HCAL



mbedded SiPM

technology: Extensive tests in beam

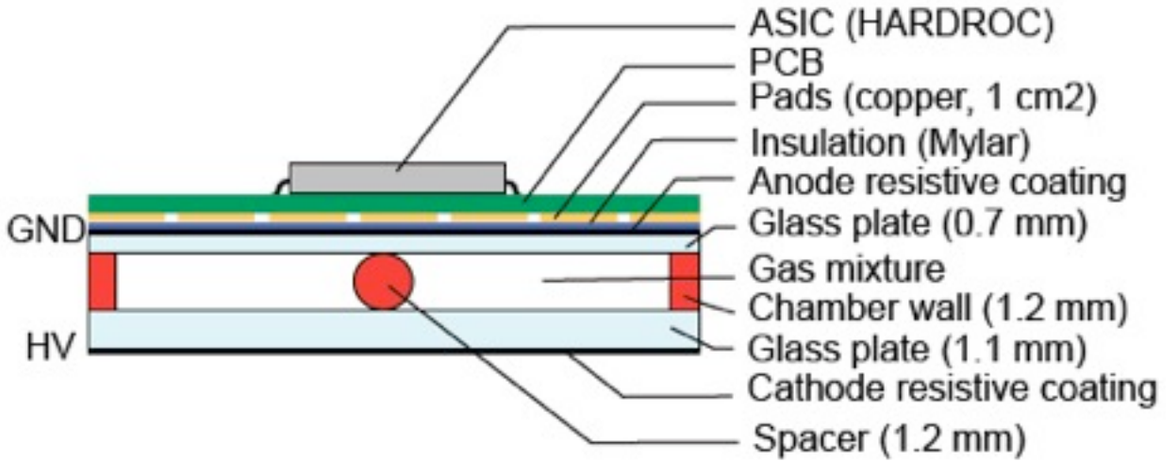
nnel system since 2006



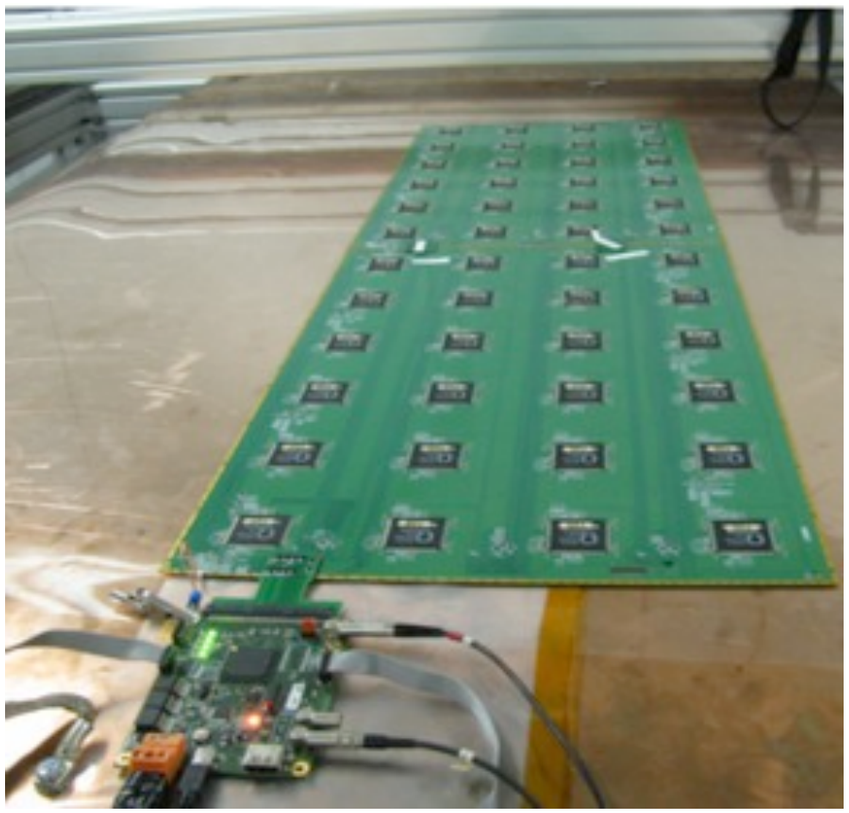
First units (144 channels) of technological demonstrator currently in test beam: - embedded electronics, power pulsing, online zero suppression channel-by-channel auto-trigger, time stamping

The Semi-Digital HCAL

- Glass RPCs with 1 cm^2 pads
  - 3 thresholds per channel: allows to keep linearity to higher energies, improved resolution at high energies compared to purely digital mode



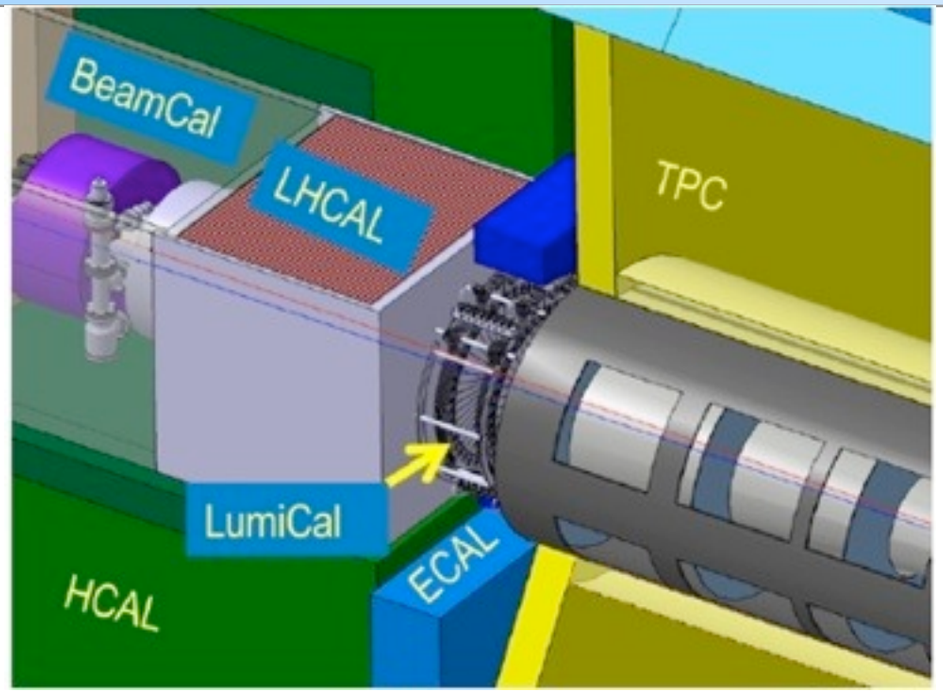
Full 1 m^3 technological prototype with
430k channels & power-pulsing successfully tested in beam



One nice (3D?) event display showing the three thresholds

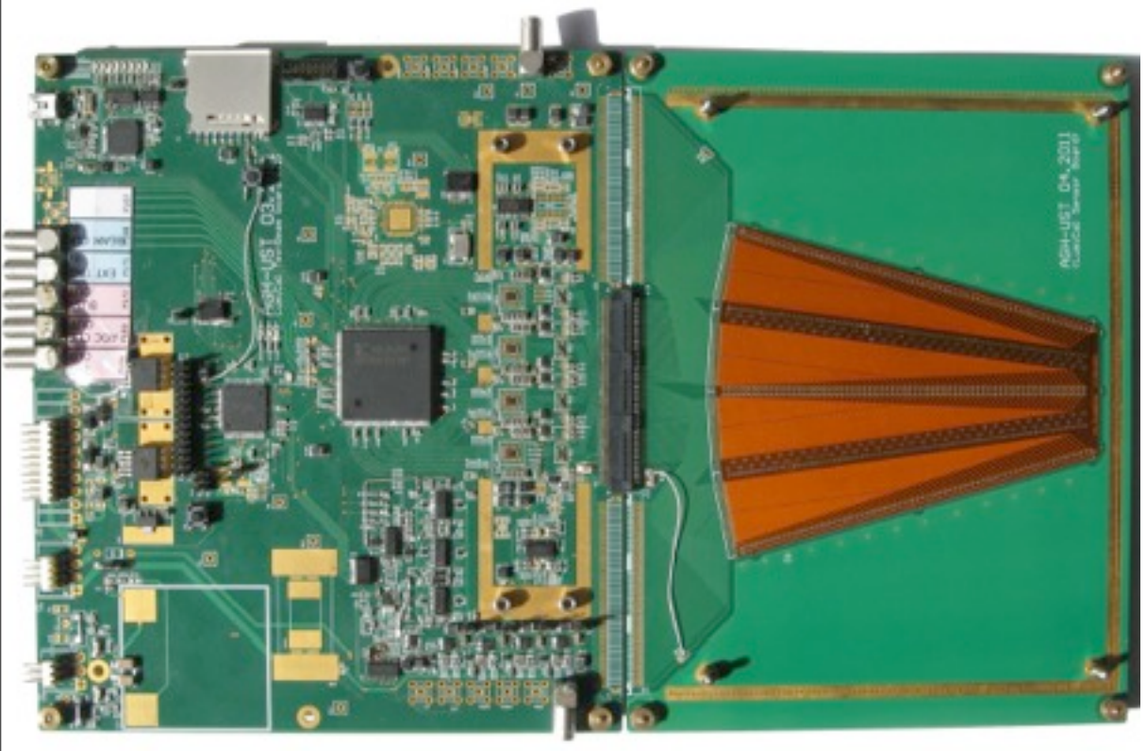
Linearity / Resolution, currently under review

Forward Calorimeters

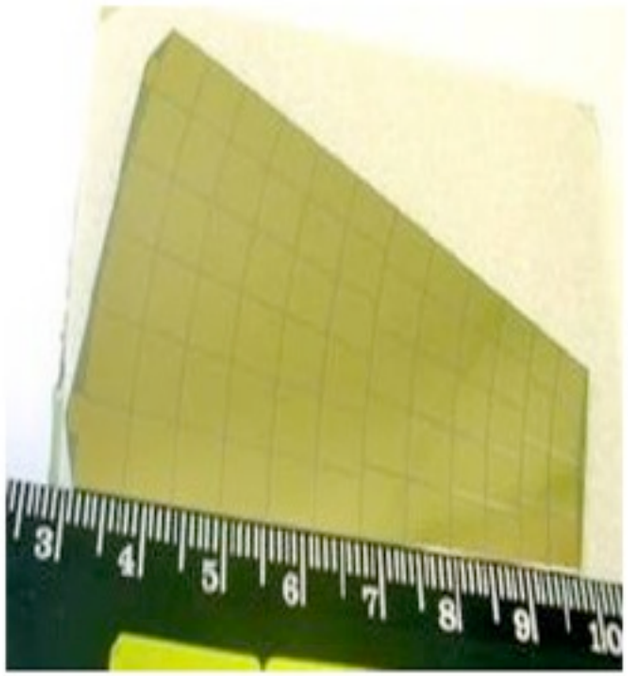


- Luminosity measurement at the 10^{-3} level with LumiCal
- Bunch-by-bunch luminosity monitoring and fast feedback for beam steering with BeamCal
- Extended coverage to low polar angles
- The only subsystems with substantial radiation hardness requirements!

Silicon sensors for LumiCal - tested in beam



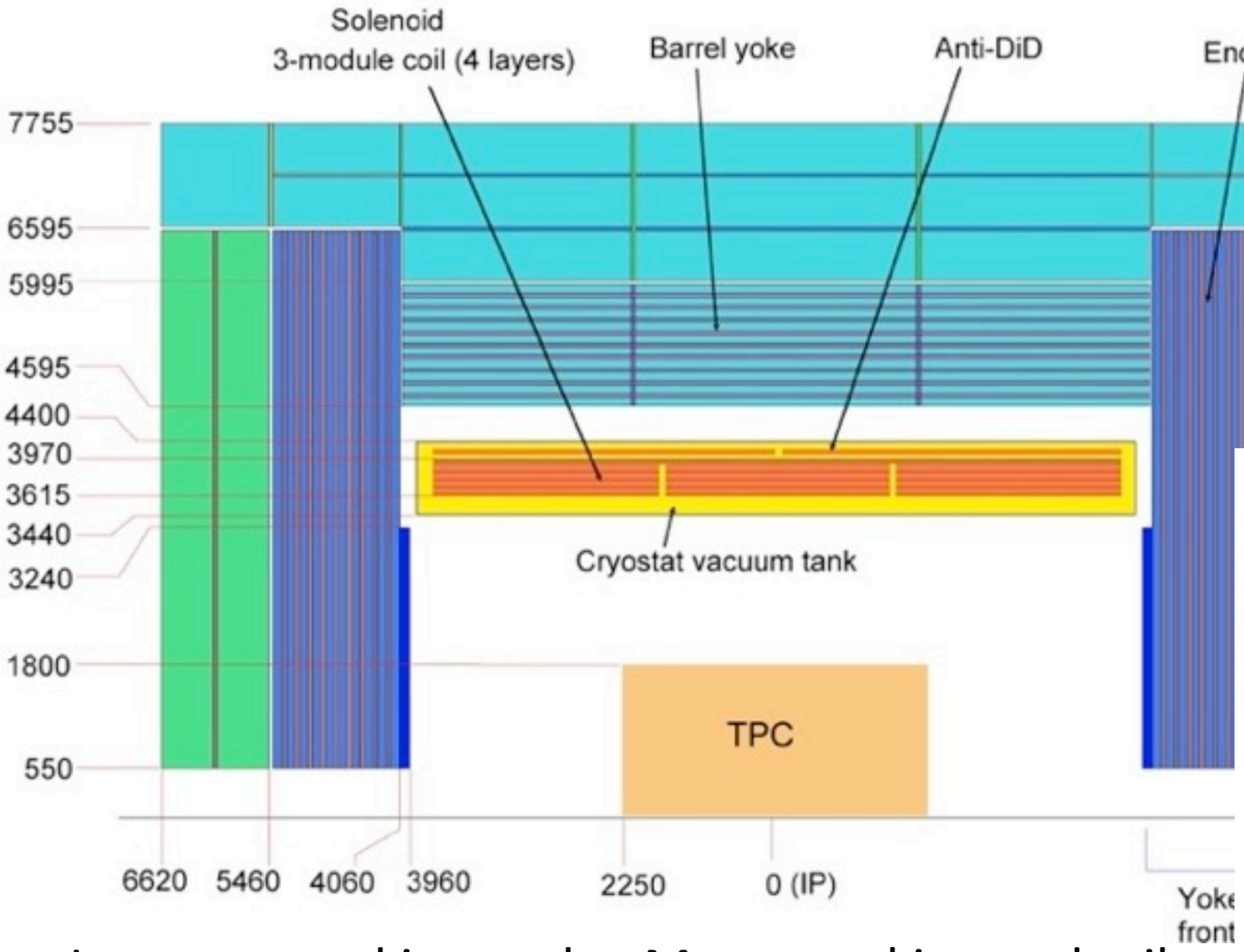
GaAs sensors and CVD Diamond for BeamCal



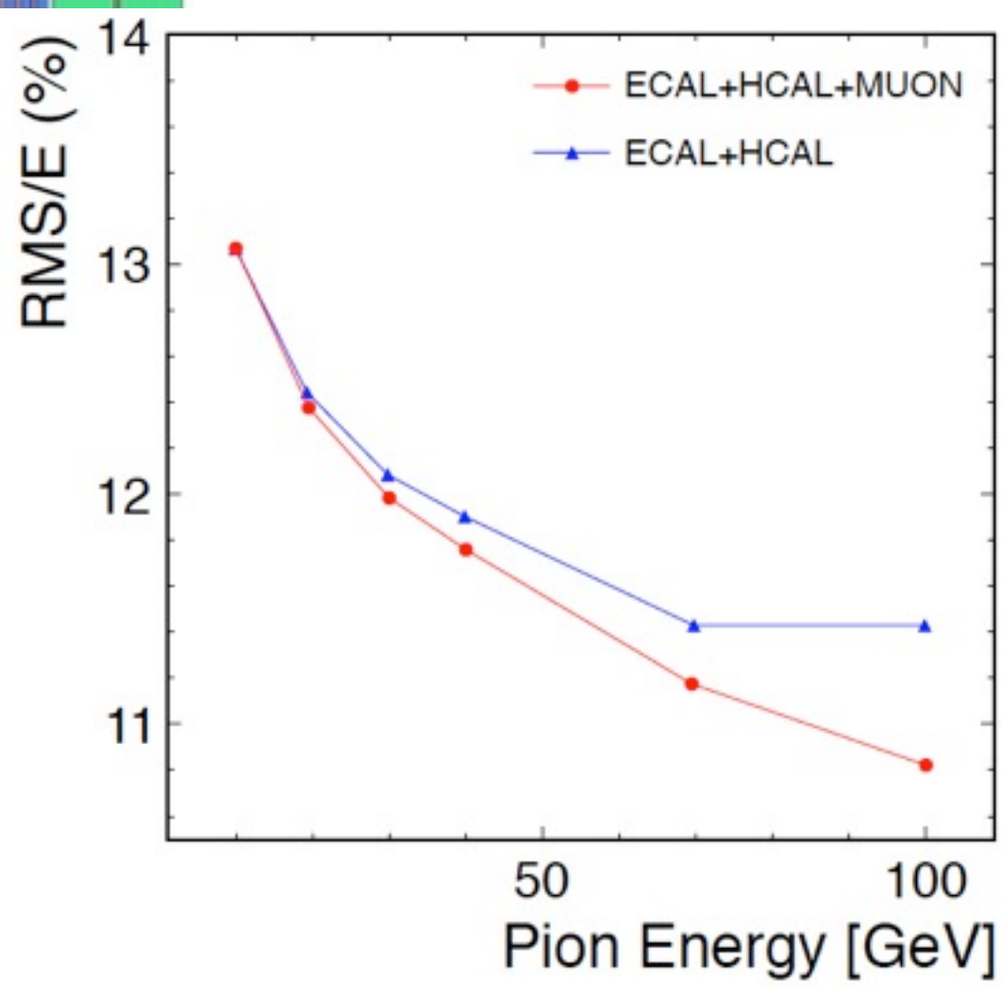
CVD Diamond shows excellent radiation hardness

GaAs shows a reduction of the charge collection efficiency to 20% after 7 MGy, still sufficient for MIP detection

Muon System, Yoke and Coil



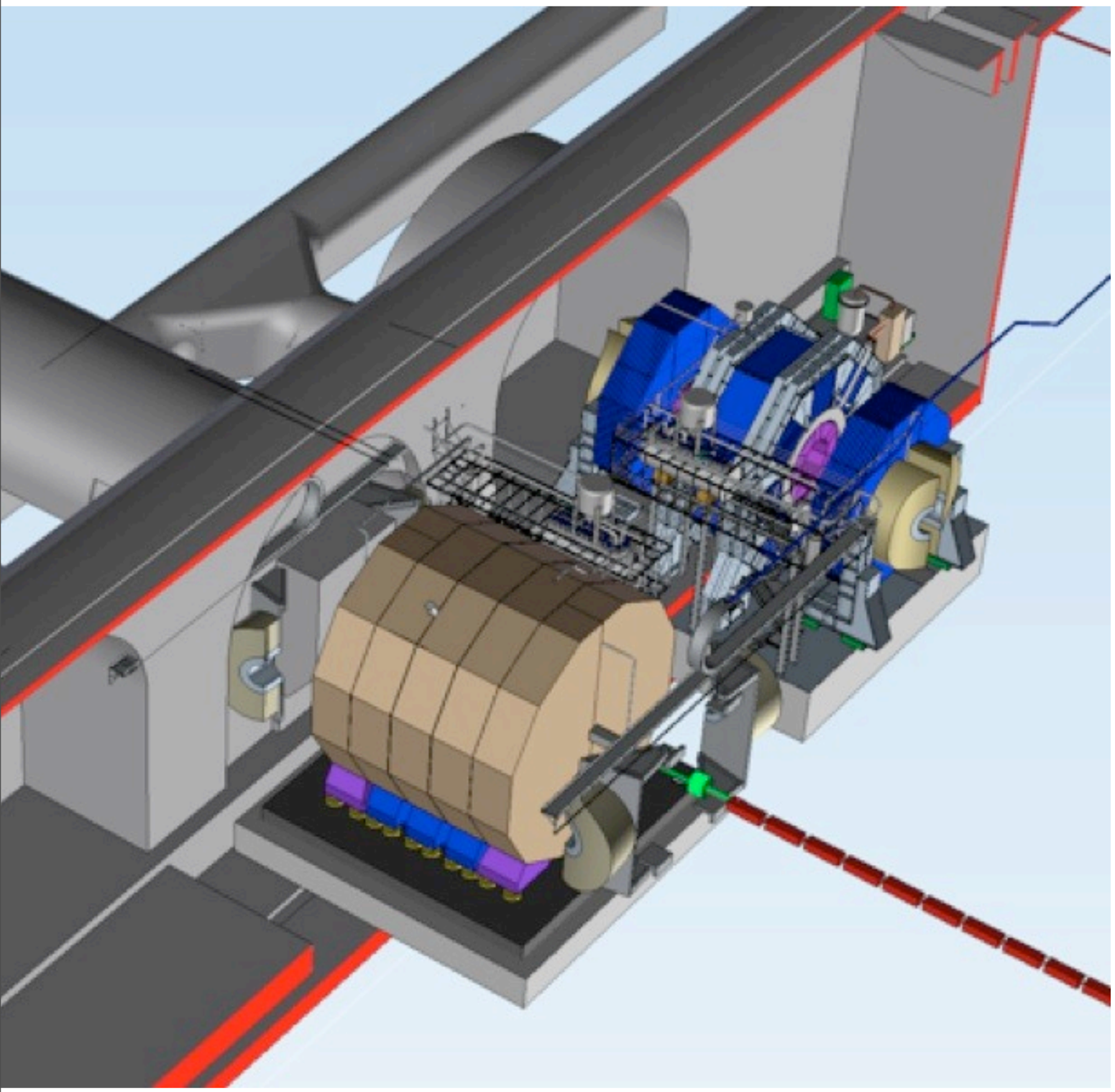
Default operations at 3.5 T, magnet designed for 4 T to allow flexibility at higher energy



- Instrumented iron yoke: Muon tracking and tail-catching
- ~ 10 mm thick, ~ 30 mm wide up to 2.7 m long extruded scintillator strips with SiPM readout

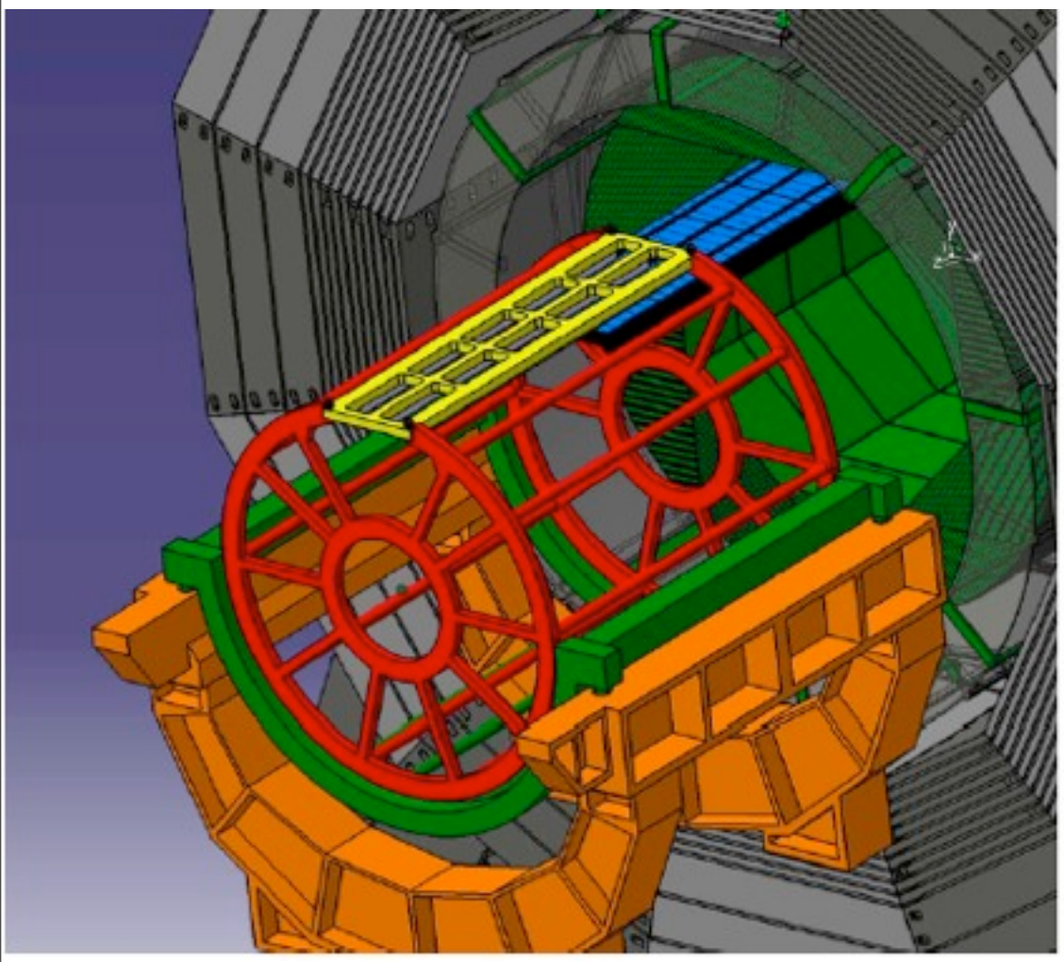
The ILD Detector System

ILD Mechanical Design

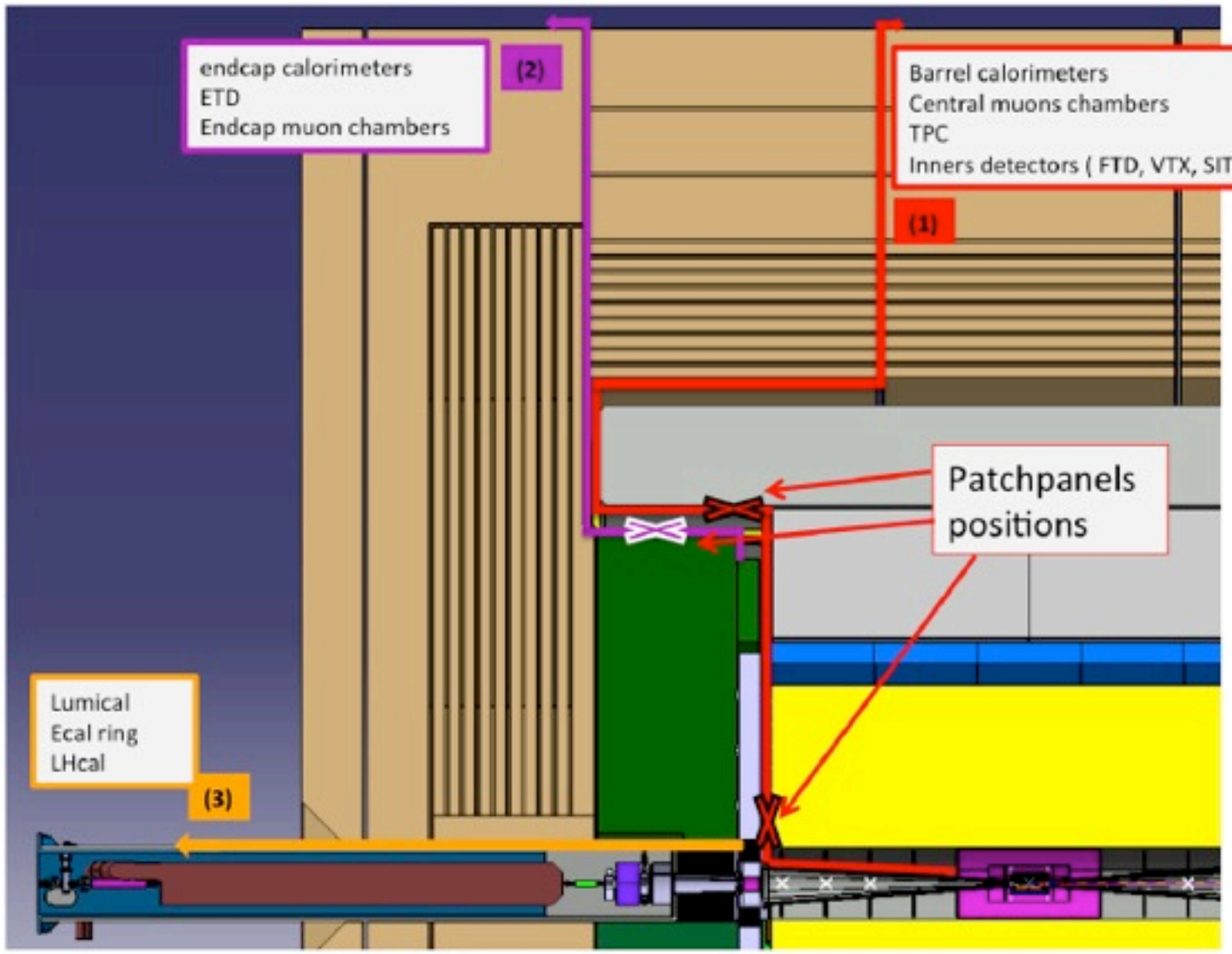


- 5 Yoke rings
  - Mounted on air cushions for easy moving during assembly / dis-assembly / maintenance
- Central ring carries cryostat and solenoid:
  - Supports calorimeters, TPC and outer Si trackers
  - Inner detector & beam pipe supported from TPC

ILD Integration

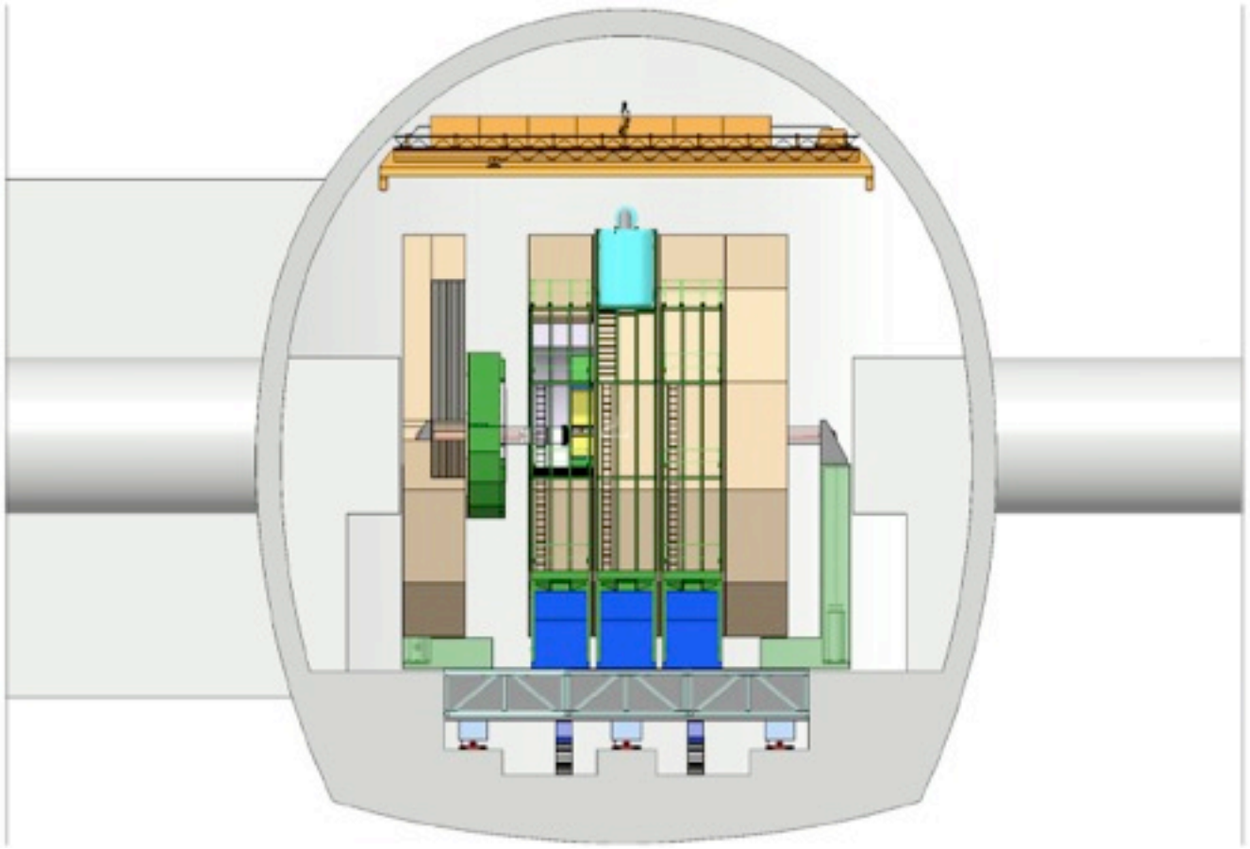


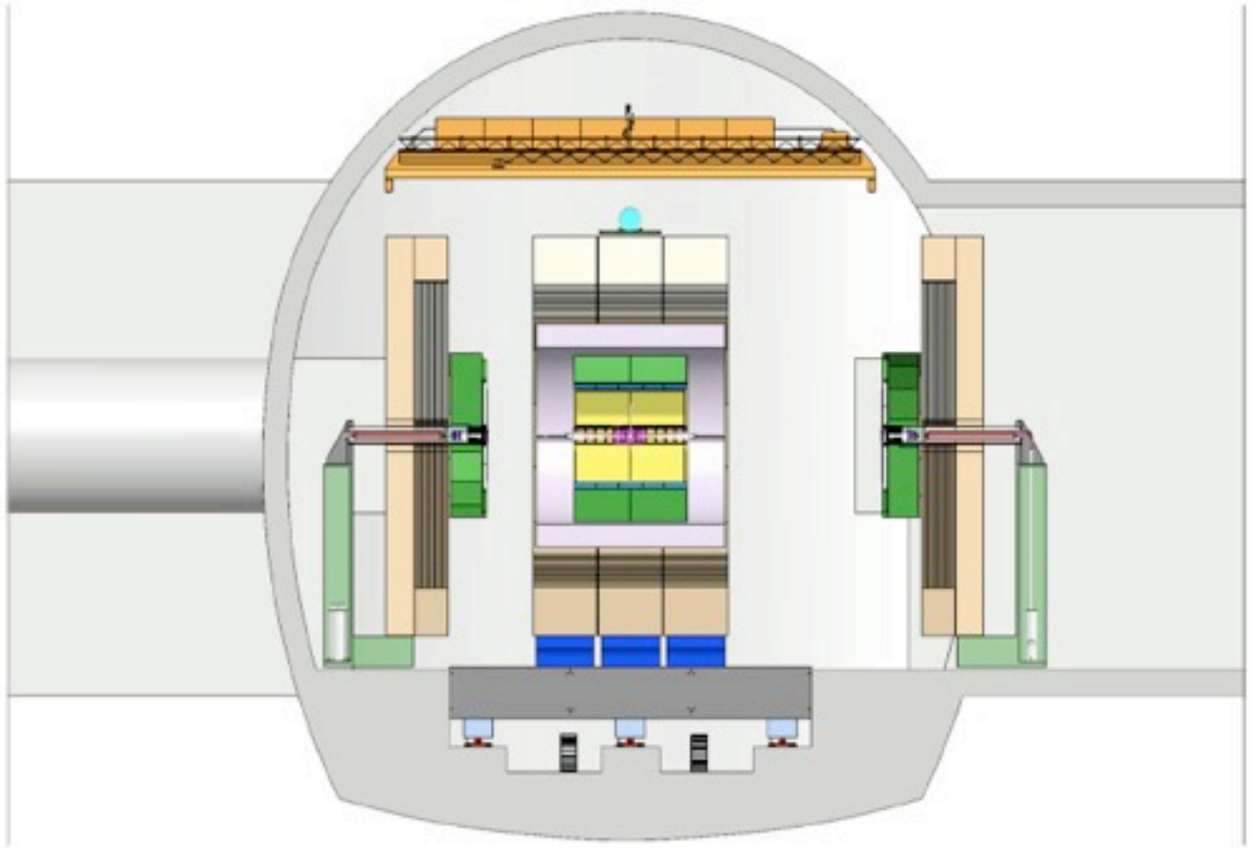
- Assembly strategy with dedicated installation fixtures



- Service paths inside of the detector for power, data, cooling

The Experimental Hall





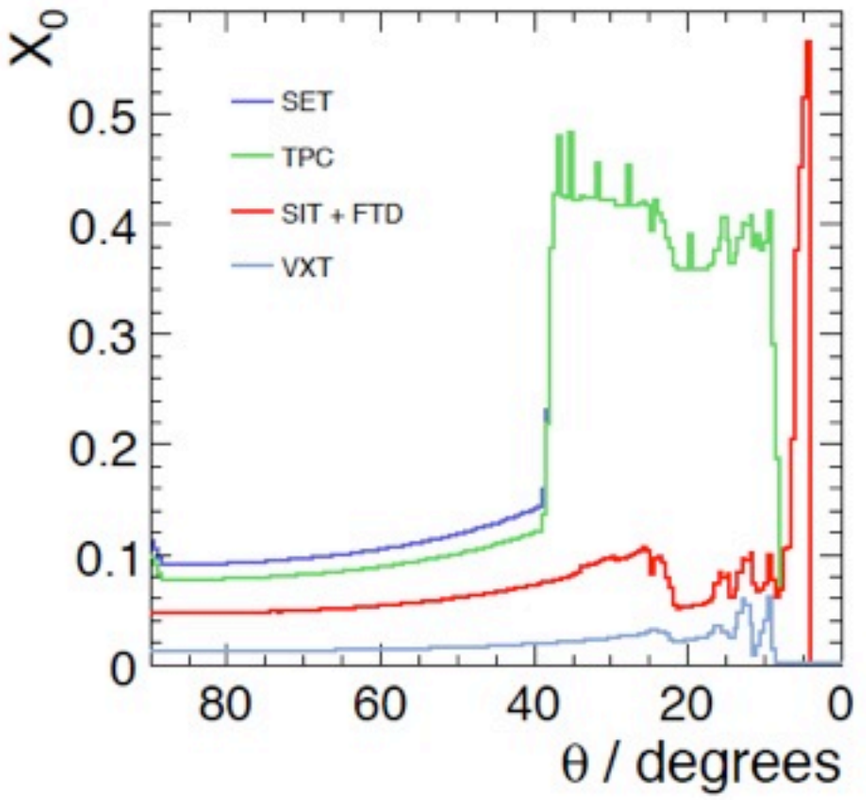
- Size of cryostat defines minimum diameter of access tunnel required for installation
  - For vertical access: Assembly of yoke rings and central detector system within cryostat on surface: 18 m diameter required
  - For horizontal access: Assembly of yoke rings and other large components in detector hall: > 8.7 m diameter required

ILD Software & Performance

ILD Simulation & Reconstruction

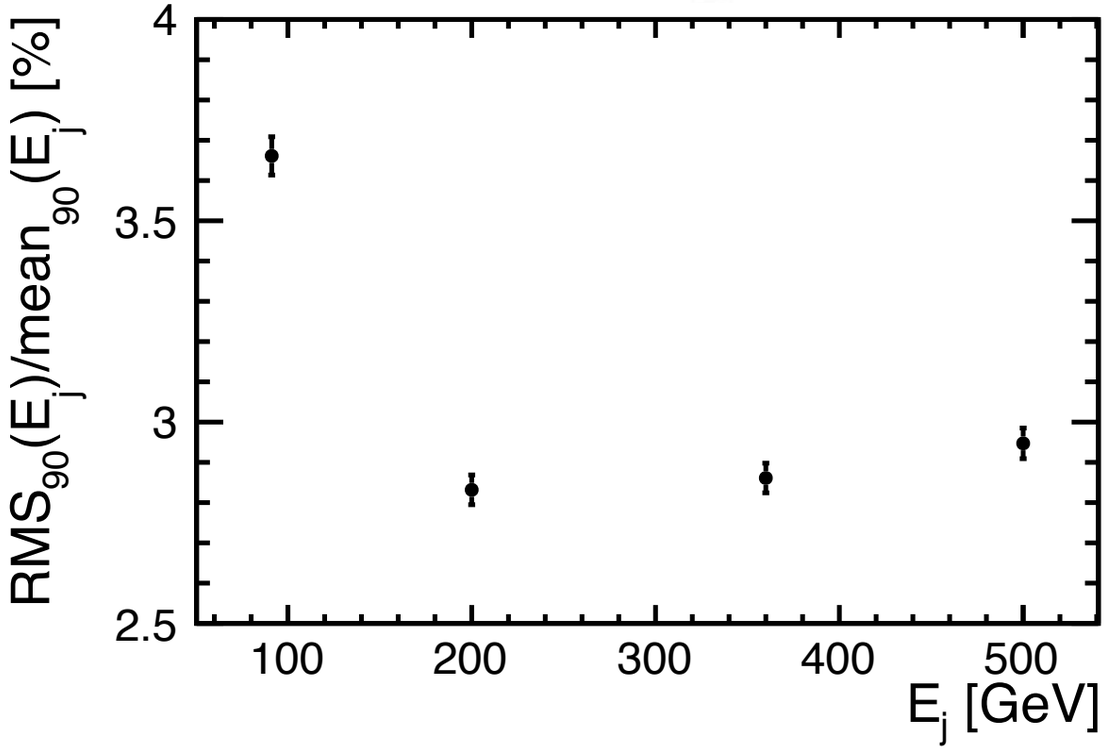
- Significant enhancements compared to the LOI
  - Increased realism in the detector description
    - Realistic geometry of most subsystems: Individual modules in trackers, engineering details (mechanical supports, electronics, cooling, cabling, ...)
    - Inclusion of dead material, cracks, ...
    - Material budget estimates based on R&D activities
  - Improved reconstruction software
    - New generation of PandoraPFA
    - Proper treatment of silicon strips
    - Completely new Kalman-Filter-based tracking
    - New flavor tagging based on boosted decision trees trained with fully simulated events

ILD Material & Performance



- Realistic description of material budget

Tracking or flavor tagging performance



- PandoraPFA performance exceeding requirements over wide energy range

ILD Physics Performance

Do we dare to show something here? If yes, which analysis?

Something on gg->had background mitigation with k_t jet finding?

Summary